

MOS INTEGRATED CIRCUIT μ PD17201A, 17207

4-BIT SINGLE-CHIP MICROCONTROLLER WITH LCD CONTROLLER/DRIVER AND A/D CONVERTER FOR INFRARED REMOTE CONTROL TRANSMITTERS

DESCRIPTION

The μ PD17201A, 17207 is a 4-bit single-chip microcontroller, used for infrared remote control transmitters, which in-tegrates an LCD controller/driver, A/D converter, and remote controller carrier generator circuit on a single chip.

For the CPU, this microcontroller employs the 17K architecture of the general-purpose register method, and it can directly execute operations between data memory addresses which would have been conventionally executed by an accumulator. In addition, all the instructions are 16-bit, 1-word instructions, enabling efficient programming.

A one-time PROM model, μ PD17P207, to which data can be written only once is also available. This one-time PROM model is useful for program evaluation of the μ PD17201A or 17207.

Detailed functionins are described in the following manual. Be sure to read this manual when designing your system.

μPD172xx Subseries User's Manual: IEU-1317

FEATURES

17K architecture
 Program memory (ROM)
 3072 x 16 bits (μPD17201A)

4096 x 16 bits (μPD17207)

• Data memory (RAM) : 336 x 4 bits (including LCD register 36 × 4 bits)

Infrared remote controller carrier generator (REM output)

LCD controller/driver
 Common pins
 Up to 136 segments can be displayed
 4 (2 can be used as segment pins)

Segment pins : 34

Voltage booster circuit for driving LCD: LCD drive voltage can be adjusted from 2.4 to 5.4 V with external

resistor

• 8-bit A/D converter : 4 channels (successive approximation method in software)

• 8-bit timer : 1 channel

Watch timer/watchdog timer
 1 channel (WDOUT output)

• 3-line serial interface : 1 channel

External interrupt pin (INT)
 1

• I/O pin : 20 (including INT)

• Instruction execution time : $4 \mu s$ (main clock: fx = 4 MHz)

488 μ s (subclock: fxT = 32.768 kHz)

• Supply voltage : VDD = 2.2 to 5.5 V (main clock: fx = 4 MHz)

: $V_{DD} = 2.0 \text{ to } 5.5 \text{ V (subclock}$: $f_{XT} = 32.768 \text{ kHz}$)

Unless otherwise specified, the μ PD17207 is treated as the representative model throughout this documents.

The information in this document is subject to change without notice.



APPLICATIONS

- Infrared remote controller for air conditioner
- Infrared remote controller with LCD display

ORDERING INFORMATION

Part Number	Pakcage
μPD17201AGF-xxx-3B9	80-pin plastic QFP (14 mm x 20 mm)
μPD17207GF-xxx-3B9	80-pin plastic QFP (14 mm x 20 mm)

Remark xxx indicates the ROM code number.

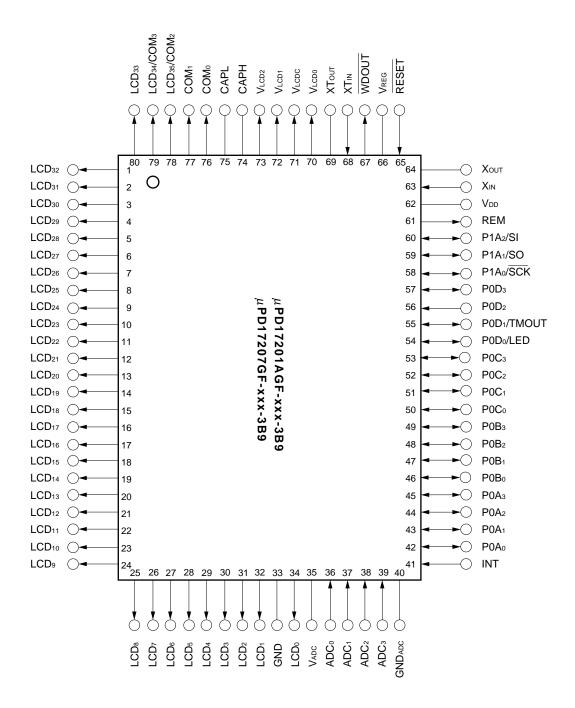
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1. PIN CONFIGURATION (TOP VIEW)



Pin Name REM : Remote controller transfer output

ADC₀-ADC₃ : A/D converter input

CAPH, CAPL : Booster capacitor connection

COM₀-COM₃ : LCD common signal output

GND, GND_{ADC} : Ground

RESET : Reset signal input

SCK : Serial clock I/O

SI : Serial data input

SO : Serial data output

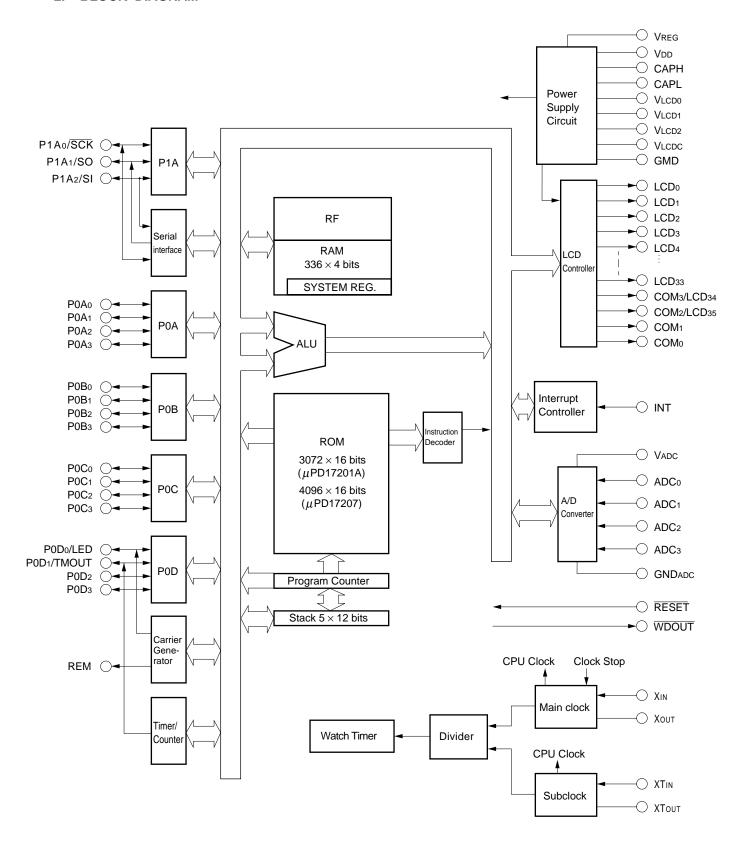
INT : External interrupt request signal input TMOUT : Timer output

LCD₀-LCD₃₅ : LCD segment signal output V_{ADC} : A/D converter power supply

LED : Remote controller transfer display output V_{DD} : Power supply

P0A₀-P0A₃ : I/O port V_{LCD0}-V_{LCD2} : LCD driver voltage output V_{LCD0}-P0B₃ : I/O port V_{LCDC} : LCD driver reference voltage adjustment

2. BLOCK DIAGRAM





3. PINS FUNCTIONS

3.1 PIN IDENTIFICATION

Pin No.	Symbol	Function	Output Type	On Reset
76 77 78 79 80 1 32 34	COMo COM1 LCD35/COM2 LCD34/COM3 LCD33 LCD32 LCD1 LCD0	Common/segment signal outputs of the LCD driver. These common and segment signal outputs are selected by LCDMD3 to LCDMD0 of the register file. • COMo to COM3 • Common signal outputs of the LCD driver • LCD35 to LCD0 • Segment signal outputs of the LCD driver	CMOS, push-pull	-
33	GND	Device ground	_	_
35	Vadc	Positive power supply of the A/D converter (V _{ADC} should be equal to V _{DD} .)	_	_
36 39	ADC ₀ ADC ₃	Analog inputs of the A/D converter (8-bit resolution)	_	-
40	GNDado	Ground of the A/D converter	_	_
41	INT	External interrupt request signal (Input). The interrupt request is generated at the rising edge of this signal.	-	Input
42 45	P0A ₀ P0A ₃	4-bit I/O port (enabling setting of inputs or outputs in 4-bit units) (Grouped I/O). Each of these pins has a pull-up resistor.	CMOS, push-pull	Input
46 49	P0B₀ P0B₃	4-bit I/O port (enabling setting of inputs or outputs in 4-bit units). (Grouped I/O).	N-channel, open-drain	Input
50 53	P0C ₀ P0C ₃	4-bit I/O port (enabling setting of inputs or outputs in 4-bit units). (Grouped I/O).	N-channel, open-drain	Input
54 55 56 57	P0D ₀ /LED P0D ₁ /TMOUT P0D ₂ P0D ₃	Port 0D/LED output or port 0D/8-bit timer output. P0Do and LED outputs are switched by NRZEN of the register file. P0D1 and 8-bit timer outputs are switched by TMOE of the register file. • P0Do to P0D3 • 4-bit I/O port • Enabling setting of inputs or outputs of each bit (Bitwise I/O) • LED • Outputs NRZ signal in synchronization with infrared remote controller signal (REM) • Outputs high level while remote controller carrier is output from REM pin • TMOUT • Output of the 8-bit timer	CMOS, push-pull	Input

(to be cont'd)



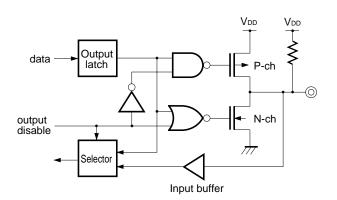
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Pin No.	Symbol	Function	Output Type	On Reset
58 59 60	P1A ₀ /SCK P1A ₁ /SO P1A ₂ /SI	Port 1A or serial interface. Port 1A and serial interface are switched by SIOEN of the register file. P1Ao to P1A2 3-bit I/O port Enabling setting of inputs or outputs of 3 bits (Grouped I/O). SCK, SO, SI SCK: Serial clock I/O SO: Serial data output SI: Serial data input	CMOS, push-pull	Input
61	REM	Signal output to an infrared remote controller. Active-high output.	CMOS, push-pull	Low-level output
62	V _{DD}	Positive power supply	_	-
63 64	X _{IN} Xout	These pins are connected to a 4-MHz ceramic or crystal oscillator for main clock oscillation.	-	(Oscillation stops)
65	RESET	System reset input. System is reset when low level is input to this pin. While this pin is low, oscillation of main clock is stopped. A pull-up resistor can be connected by mask option.	-	Input
66	Vreg	Output of the voltage regulator for the subclock oscillation circuit. Connect external 0.1 - μ F capacitor to this pin when using the subclock.	-	_
67	WDOUT	Output for detection of a program overrun. This pin outputs a low level when an overflow in the watchdog timer or an overflow/underflow in the stack is detected. Connect this pin to the RESET pin	N-ch open drain	High- impedance
68 69	XT _{IN} XT _{OUT}	These pins are connected to a 32.768-kHz crystal oscillator for subclock oscillation.	-	(Oscillates)
71	VLCDC	Input to regulate the reference voltage to LCD driver.	_	_
70 72 73	VLCD0 VLCD1 VLCD2	Reference voltage outputs to LCD driver. • VLCD0: Reference voltage output • VLCD1: Doubler output (Two times the reference voltage) • VLCD2: Tripler output (Three times the reference voltage)	-	-
74 75	CAPH CAPL	These pins are connected to a capacitor to boost the LCD drive voltage.	-	-

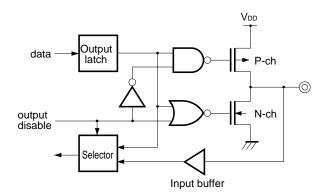
3.2 EQUIVALENT CIRCUITS OF PINS

The followings are equivalent circuits (partially simplified) of the respective pins of the μ PD17207.

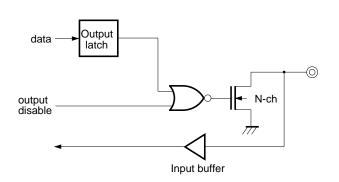
(1) P0A



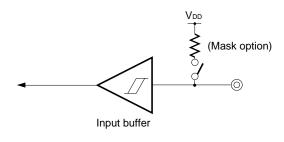
(4) P0D, P1A



(2) P0B

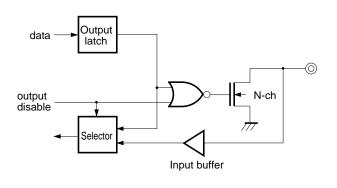


(5) RESET

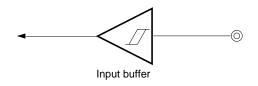


Schmitt trigger input with hysteresis characteristics

(3) P0C



(6) INT



Schmitt trigger input with hysteresis characteristics



3.3 PROCESSING OF UNUSED PINS

Process unused pins as follows:

Table 3-1 Processing of Unused Pins

(a) Port pins

	Pin Name	Recommended Processing of Unused Pins									
		Internally	Externally								
Input mode	P0A	(Connect pull-up resistor.)	Open.								
	POC	Directly connect to GND.									
	POD, P1A	-	Connect each pin to V _{DD} or GND via resistor ^{Note} .								
Output mode	P0A (CMOS port)	Outputs high level.	Open.								
	P0D, P1A (CMOS port)	-									
	P0B, P0C (N-ch open-drain port)	Outputs low level.									

Note When pulling this pin up (connecting the pin to V_{DD} via resistor) or down (connect the pin to GND via resistor), exercise care not to decrease the drive capability or increase the power consumption of the port. When a high resistance is used for pulling up or down, make sure that noise is not superimposed on the pin.

(b) Pins other than port pins

Pin Name	I/O Format	Recommended Processing of Unused Pin
ADC ₀ -ADC ₃	Input	Directly connect to GND.
CAPH, CAPL	Output	Open
COM ₀ , COM ₁ , COM ₂ /LCD ₃₅ , COM ₃ /LCD ₃₄	Output	Open
INT ^{Note}	Input	Directly connect to GND.
LCD ₀ -LCD ₃₃	Output	Open
REM	Output	Open
VADC	_	Directly connect to VDD.
VLCD0-VLCD2	Output	Open
VLCDC	_	Directly connect to VDD or VLCD0.
WDOUT	Output	Directly connect to GND.
XIN, XTIN	Input	Directly connect to GND.
Хоит	_	Directly connect to VDD.
ХТоит		Directly connect to VREG.

Note Because the INT pin is also used as a test mode setting pin, directly connect this pin to GND when it is not used.

- Cautions 1. It is recommended to fix the input or output mode and the output level of the pin by repeatedly setting them in each loop of the program.
 - 2. Stop the voltage booster circuit by using the display mode register when the LCD driver/controller is not in use.

3.4 NOTES ON USING RESET AND INT PINS

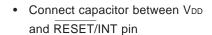
In addition to the functions shown in 3.1 PIN IDENTIFICATION, the $\overline{\text{RESET}}$ and INT pins also have a function to set a test mode (for IC testing) in which the internal operations of the μ PD17207are tested.

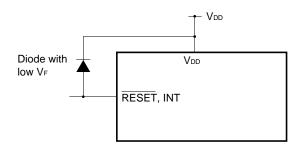
When a voltage higher than V_{DD} is applied to either of these pins, the test mode is set. This means that, even during ordinary operation, the μ PD17207 may be set in the test mode if a noise exceeding V_{DD} is applied.

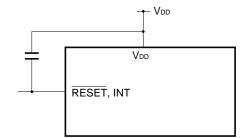
For example, if the wiring length of the RESET or INT pin is too long, noise superimposed on the wiring line of the pin may cause the above problem.

Therefore, keep the wiring length of these pins as short as possible to suppress the noise; otherwise, take noise preventive measures as shown below by using external components.

• Connect diode with low V_F between V_{DD} and RESET/INT pin









4. MEMORY SPACE

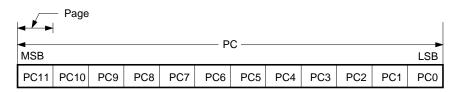
4.1 PROGRAM COUNTER (PC)

The program counter (PC) specifies an address of the program memory (ROM).

The program counter is a 12-bit binary counter as shown in Fig. 4-1.

Its contents are initialized to address 0000H at reset.

Fig. 4-1 Configuration of Program Counter



4.2 PROGRAM MEMORY (ROM)

The configuration of the program memory of the μ PD17201A/17207 is as follows:

Part Number	Capacity	Address
μPD17201A	3072 x 16 bits	0000H-0BFFH
μPD17207	4096 x 16 bits	0000H-0FFFH

The program memory stores a program, interrupt vector table, and fixed data table.

The program memory is addressed by the program counter.

Fig. 4-2 shows the program memory map. The entire range of the program memory can be addressed by the BD addr, BR @AR, CALL @AR, MOVT DBF, and @AR instructions. Note, however, that the subroutine entry addresses that can be specified by the CALL addr instruction are from 0000H to 07FFH.

Address 16 bits 0000H Reset start address Branch addresses for 0001H BR addr instruction Serial interface interrupt vector 0002H Watch timer interrupt vector Subroutine entry Page 0 addresses for CALL Branch addresses for 0003H External input (INT) interrupt vector addr instruction BR @AR instruction 0004H 8-bit timer interrupt vector Subroutine entry addresses for CALL @AR instruction 07FFH Table reference $(\mu PD17201A)$ 0 B F F H Page 1 addresses for MOVT DBF, @AR instruction $(\mu PD17207)$ 0 F F F H

Fig. 4-2 Program Memory Map

4.3 STACK

A stack is a register to save a program return address and the contents of system registers (to be described later) when a subroutine is called or when an interrupt is accepted.

4.3.1 Stack Configuration

A stack consists of a stack pointer (a 3-bit binary counter), five 12-bit address stack registers (ASR), and three 7-bit interrupt stack registers (INTSK). Refer to **Fig. 4-3**.

The stack pointer specifies the addresses of the address stack registers.

The value of this pointer is initialized to 5H at reset.

When the value of the stack pointer is 6H or 7H, the WDOUT pin goes low.

Stack Pointer Address Stack Registers (SP) (ASR) b₂ b1 b₀ b11 **b**10 b9 b8 b7 b6 b5 bз b2 b1 bo SPb₂ SPb₁ SP_{b0} **→** 0H Address stack register 0 Address stack register 1 → 1H **►** 2H Address stack register 2 **►** 3H Address stack register 3 **►** 4H Address stack register 4 ► 5H Undefined WDOUT pin goes low when the contents Undefined ► 6H of the stack pointer 7H Undefined are 6H-7H. Interrupt Stack Registers (INTSK) 0H BANKSK0 BCDSK0 CMPSK0 CYSK0 ZSK0 IXESK0

Fig. 4-3 Stack Configuration

Fig. 4-4 Stack Pointer

BCDSK1 CMPSK1

BCDSK2 CMPSK2 CYSK2

CYSK1

RF: address 01	Bit 3	Bit 2	Bit 1	Bit 0							
	0 SP										
Read/write	R/W										
Initial value at reset	0	1	0	1							

BANKSK1

BANKSK2

1H

2H

Read = R, Write = W

ZSK1

ZSK2

IXESK1

IXESK2

4.3.2 Function of Stack

The address stack register stores a return address when the subroutine call instruction or table reference instruction (first instruction cycle) is executed or when an interrupt is accepted. It also stores the contents of the address registers (ARs) when a stack manipulation instruction (PUSH AR) is executed.

The WDOUT pin goes low if a subroutine call or interrupt exceeding 5 levels is executed.

The interrupt stack register (INTSK) saves the contents of the bank register (BANK) and program status word (PSWORD) when an interrupt is accepted. The saved contents are restored when an interrupt return (RETI) instruction is executed.

INTSK saves data each time an interrupt is accepted, but the data stored first is lost if more than 3 levels of interrupts occur.

4.3.3 Stack Pointer (SP) and Interrupt Stack Pointer

Table 4-1 shows the operations of the stack pointer (SP).

The stack pointer can take eight values, 0H-07. Because there are only five stack registers available, however, the WDOUT pin goes low if the value of SP is 6 or greater.

Table 4-1 Operations of Stack Pointer

Instruction	Value of Stack Pointer (SP)	Counter of Interrupt Stack Register
CALL addr		
CALL @AR		
MOVT DBF, @AR	-1	0
(1st Instruction Cycle)		
PUSH AR		
When Interrupt Is Accepted	-1	-1
RET		
RETSK		
MOVT DBF, @AR	+1	0
(2nd Instruction Cycle)		
POP AR		
RETI	+1	+1

4.4. DATA MEMORY (RAM)

Data memory (random access memory) stores data for operations and control. It can be read-/write-accessed by instructions.

4.4.1 Memory Configuration

Figure 4-4 shows the configuration of the data memory (RAM).

The data memory consists of three "banks": BANK0, BANK1, and BANK2.

In each bank, every 4 bits of data is assigned an address. The higher 3 bits of the address indicate a "row address" and the lower 4 bits of the address indicate a "column address". For example, a data memory location indicated by row address 1H and column address 0AH is termed a data memory location at address 1AH. Each address stores data of 4 bits (= a "nibble").

In addition, the data memory is divided into following six functional blocks:

(1) System register (SYSREG)

A system register (SYSREG) is resident on addresses 74H to 7FH (12 nibbles long) of each bank. In other nibbles, each bank has a system register at its addresses 74H to 7FH.

(2) Data buffer (DBF)

A data buffer is resident on addresses 0CH to 0FH (4 nibbles long) of bank 0 of data memory.

The reset value is 0320H.

(3) General register (GR)

A general register is resident on any row (16 nibbles long) of any bank of data memory.

The row address of the general register is indicated by the general pointer (RP) in the system register (SYSREG).

(4) LCD segment data register (LCD register)

A register sets the segment output data of LCD.

Refer to 11. LCD CONTROLLER/DRIVER.

An LCD segment data register is resident on addresses 40H to 63H (36 nibbles long) of BANK0 of data memory.

(5) Port register

A port data register is resident on addresses 70H to 73H (12 nibbles) of each bank of data memory.

However, addresses 71H to 73H of BANK1 and addresses 70H to 73H of BANK2 are assigned nothing.

Therefore, a port data register is substantially 4 nibbles long.

The reset value is 0.

(6) General-purpose data memory

The general-purpose data memory area is an area of the data memory excluding the system register area, the LCD register area, and the port register area. This memory area has a total of 300 nibbles (76 nibbles in BANK0 and 224 nibbles in BANK1 and BANK2).

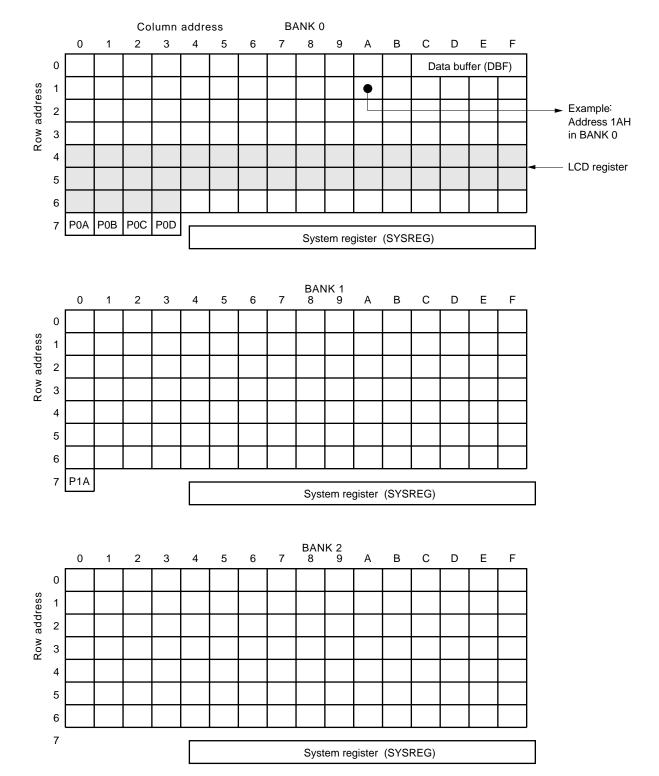


Fig. 4-5 Configuration of Data Memory

4.4.2 System Registers (SYSREG)

The system registers are registers that are directly related to control of the CPU. These registers are mapped to addresses 74H-7FH on the data memory and can be referenced regardless of bank specification.

The system registers include the following registers:

Address registers (AR0-AR3)

Window register (WR)

Bank register (BANK)

Memory pointer enable flag (MPE)

Memory pointers (MPH, MPL)

Index registers (IXH, IXM, IXL)

General register pointers (RPH, RPL)

Program status word (PSWORD)

Fig. 4-6 Configuration of System Register

Address		74H 75H 76H 77H											78H					79	Н		7AH					7E	ВH			70	Н			70	ЭН			7	ΞH			7F	Н					
Name	Address register												Wi re(te		re	an egis	ste		Data memory													ı	eg ooi	ne jist	er			st	rog atu	is t							
																	row address pointer (MP)													(RI	P)				(PSWORD)												
Symbol	AR 3 AR 2 A					AF	₹ 1		,	٩R	0	0		WR		Е	BAI	ΝK			IX	Н			IX		IXL				RPH					RI	PL	PSW				,						
																					MPH MPL													<u> </u>														
Bit	bз	b2	b1	bo	bз	b2	b1	b o	Ьз	b2	b1	b o	bзI) 2	b1	bo	bзl	02	b1	bo	bз	b2	b1	b o	Ьз	b2	b1	b ₀	Ьз	b2	b1	b o	bз	b2	b1	b o	bз	b2	b1	b ₀	bз	b2	b1	b ₀	b з	b2	b1	bo
Data	0	0	0	0	*					(A	R)					•	•					NK 0		•	M P E	0	0	*	(1	MF		IX))			•	0	0	\	(1	RF	2)	•	B C D	C M P		Z	I X E
Initial Value At Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Un	de	fin	ed	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

4.4.3 General Register (GR)

A general register is a 16-word register on the data memory and used for arithmetic operations and transfer of data to and from the data memory.

(1) Configuration of general register

Figure 4-7 shows the configuration of the general register.

A general register occupies 16 nibbles (16 x 4 bits) on a selected row address of the data memory.

The row address is selected by the general register pointer (RP) of the system register. The RP having five significant bits can point to any row address in the range of 0H to 7H of each bank (BANK0 to BANK2).

(2) Functions of the general register

The general register enables an arithmetic operation and data transfer between the data memory and a selected general register by a single instruction. As a general register is a part of the data memory, you can say that the general register enables arithmetic operation and data transfer between two locations of the data memory. Similarly, the general register can be accessed by a Data Memory Manipulation instruction as it is a part of the data memory.

General register pointer (RP) **RPH** RPL BANK0 Column address b₂ b₁ b_2 b_0 bз bo 0 1 2 3 4 5 6 7 8 9 A B CDE Х e d e d ← Example: General registers (16 nibbles) General registers → 3 when t RP = 0000010Bs i → 5 g → 6 n е General register Port register d RP System registers settable range BANK1 В С Same system D registers exist f а → 6 g System registers BANK2 **→** 0 0 1 → 2 → 3 → 5 → 6 System registers

Fig. 4-7 Configuration of General Registers

4.4.4 Data Buffer (DBF)

The data buffer on the data memory is used for data transfer to and from peripheral hardware and for storage of data during table reference.

(1) Functions of the Data Buffer

The data buffer has two major functions: a function to transfer to and from hardware and a function to read constant data from the program memory (for table reference). Figure 4-8 shows the relationship between the data buffer and peripheral hardware.

Data buffer (DBF) Peripheral Peripheral hardware address Internal bus 01 H Serial interface (SIOSFR) 8-bit timer 02 H (TMC, TMM) Carrier generator for 03 H/04 H remote controller Program memory (ROM) 05H A/D converter (ADCR) Constant data Address register (AR) 40H

Fig. 4-8 Data Buffer and Peripheral Hardware

Table 4-2 Relations between Peripheral Hardware and Data Buffer

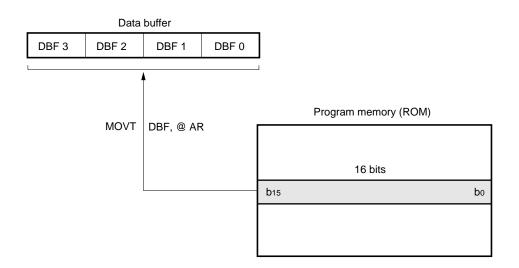
	Peripheral Registers Transferring Data with Data Buffer						
Peripheral Hardware	Name	Symbol	Peripheral Address	Data Buffer Used	Execution of Put/Get		
Serial Interface	Shift Register	SIOSFR	01H	DBF0, DBF1	Both PUT & GET		
8-bit Timer	8-bit counter	TMC	02H	DBF0, DBF1	Only GET		
	8-bit modulo register	TMM	02H	DBF0, DBF1	Only PUT		
Remote Controller Carrier Generator	NRZ low-level period setting modulo register	NRZLTMM	03H	DBF0, DBF1	Both PUT & GET		
Circuit	NRZ high-level period setting modulo register	NRZHTMM	04H	DBF0, DBF1	PUT (Clears bits 2 and 3 of DBF1 to 0.) GET (Always clears bits 2 and 3 of DBF1 to 0.)		
A/D Converter		ADCR	05H	DBF0, DBF1	Both PUT & GET		
Address Register Address register		AR	40H	DBF0-DBF3	PUT (Bits 0-3 of AR3 are don't care.) GET (Always clears bits 0-3 of AR3 to 0.)		

(2) Table reference

A MOVT instruction reads constant data from a specified location of the program memory (ROM) and sets it in the data buffer.

The function of the MOVT instruction is explained below.

MOVT DBF,@AR: Reads data from a program memory location pointed to by the address register (AR) and sets it in the data buffer (DBF).



(3) Note on using data buffer

When transferring data to/from the peripheral hardware via the data buffer, the unused peripheral addresses, write-only peripheral registers (only when executing PUT), and read-only peripheral registers (only when executing GET) must be handled as follows:

· When device operates

Nothing changes even if data is written to the read-only register.

If the unused address is read, an undefined value is read. Nothing changes even if data is written to that address.

• Using 17K Series assembler

An error occurs if an instruction is executed to read a write-only register.

Again, an error occurs if an instruction is executed to write data to a read-only register.

An error also occurs if an instruction is executed to read or write an unused address.

• If an in-circuit emulator (IE-17K or IE-17K-ET) is used (when instruction is executed for patch processing)

An undefined value is read if an attempt is made to read the data of a write-only register, but an error does not occur.

Nothing changes even if data is written to a read-only register, and an error does not occur.

An undefined value is read if an unused address is read; nothing changes even if data is written to this address. An error does not occur.

4.5 REGISTER FILE (RF)

The register file mainly consists of registers that set the conditions of the peripheral hardware.

These registers can be controlled by dedicated instructions PEEK and POKE, and the embedded macro instructions of AS17K, SETn, CLRn, and INITFLG.

4.5.1 Configuration of Register File

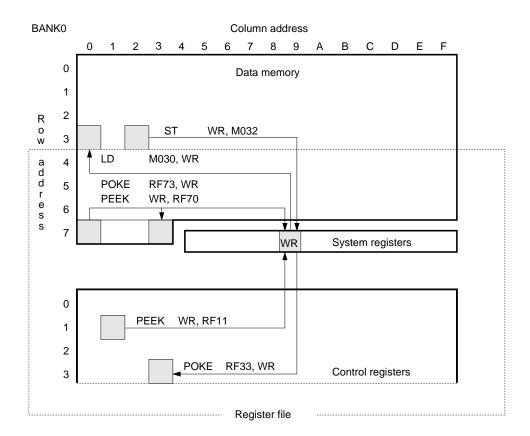
Fig. 4-9 shows the configuration of the register file and how the register file is accessed by the PEEK and POKE instructions.

The control registers are controlled by using dedicated instructions PEEK and POKE. Since the control registers are assigned to addresses 00H-3FH regardless of the bank, the addresses 00H-3FH of the general-purpose data memory cannot be accessed when the PEEK or POKE instruction is used.

The addresses that can be accessed by the PEEK and POKE instructions are the addresses 00H-3FH of the control registers and 40H-7FH of the general-purpose data memory. The register file consists of these addresses.

The control registers are assigned to addresses 80H-BFH on the IE-17K to facilitate debugging.

Fig. 4-9 Configuration of Register File and Accessing Register File by PEEK and POKE Instructions



4.5.2 Control Registers

The control registers consists of a total of 64 nibbles (64 x 4 bits) of the addresses 00H-3FH of the register file. Of these, however, only 20 nibbles are actually used. The remaining 44 nibbles are unused registers that are inhibited from being read or written.

When the "PEEK WR, rf" instruction is executed, the contents of the register file addressed by "rf" are read to the window register.

When the "POKE rf, WR" instruction is executed, the contents of the window register are written to the register file addressed by "rf".

When using the 17K series assembler, the macro instructions listed below, which are embedded as flag type symbol manipulation instructions, can be used. The macro instructions allow the contents of the register file to be manipulated in bit units.

For the configuration of the control register, refer to Fig. 15-1 Register File List.

SETn : Sets flag to "1" CLRn : Sets flag to "0"

SKTn : Skips if all flags are "1"
SKFn : Skips if all flags are "0"
NOTn : Complements flag
INITFLG : Initializes flag

4.5.3 Notes on Using Register Files

When using the register files, bear in mind the points described below. For details, refer to μ PD172xx Subseries User's Manual.

(1) When manipulating control registers (read-only and unused registers)
When manipulating the read-only (R) and unused control registers by using the assembler or in-circuit emulator, keep in mind the following points:

· When device operates

Nothing changes even if data is written to the read-only register.

If the unused register is read, an undefined value is read; nothing is changed even if data is written to this register.

· Using 17K series assembler

An error occurs if an instruction is executed to write data to the read-only register.

An error also occurs if an instruction is executed to read or write the unused address.

 When an in-circuit emulator (IE-17K or IE-17K-ET) is used (when instruction is executed for patch processing)

Nothing changes even if data is written to the read-only register, and an error does not occur.

An undefined value is read if the unused address is read; nothing changes even if data is written to this address. An error does not occur.

(2) Symbol definition of register file

An error occurs if a register file address is directly specified as a numeral by the operand "rf" of the "PEEK WR, rf" or "POKE rf, WR" instruction if the 17K Series Assembler is being used.

Therefore, the addresses of the register file must be defined in advance as symbols.

To define the addresses of the control registers as symbols, define them as the addresses 80H-BFH of BANKO.

The portion of the register file overlapping the data memory (40H-7FH), however, can be defined as symbols as is.

5. PORTS

5.1 PORT 0A

This port is a 4-bit I/O port. The four bits of this port are assigned all inputs or all outputs. This assignment is performed by P0AGIO of the register file. Transferring data from and to this port is performed via the P0A port register (address 70H of BANK0).

This port is set in the input mode at reset.

This port can release the standby mode when the standby mode has been set and if all the bits of the port are not set at high level.

This port is connected to the pull-up resistor regardless of whether the input or output mode is specified.

5.2 PORT 0B

This port is a 4-bit I/O port. The four bits of this port are assigned all inputs or all outputs. This assignment is performed by P0BGIO of the register file. Transferring data from and to this port is performed via the P0B port register (address 71H of BANKO).

This port is set in the input mode at reset.

This port can release the standby mode when the standby mode has been set and if all the bits of the port are not at low level.

In the output mode, this port requires an external pull-up resistor because it works as an N-ch open-drain output.

5.3 PORT 0C

This port is a 4-bit I/O port. The four bits of this port are assigned all inputs or all outputs. This assignment is performed by P0CGIO of the register file. Transferring data from and to this port is performed via the P0C port register (address 72H of BANKO).

This port is set in the input mode at reset.

In the output mode, this port requires an external pull-up resistor because it works as an N-ch open-drain output.

5.4 PORT 0D

This port works as a 4-bit I/O port, an LED output, and an external signal output for the 8-bit timer.

One of these functions is selected by NRZEN and TMOE of the register file.

(1) Using the whole port as a 4-bit I/O port

The pins of this port can be individually assigned input or output. This assignment is performed by P0DBIO3 to P0DBIO0 of the register file. Transferring data from and to this port is performed via the P0D (address 73H of BANK0).

(2) Using the P0Do pin as an LED output

The LED output pin and the I/O port (P0D₀) pins are selected by NRZEN. The LED output pin outputs an NRZ signal in synchronization with the REM output.

(3) Using the P0D₁ pin as an external signal output for the 8-bit timer

The external signal output pin for the 8-bit timer and the I/O port (P0D1) pins are selected by TMOE.

5.5 PORT 1A

This port works as a 3-bit general I/O port and as serial interface. The I/O port or serial interface is selected by SIOEN of the register file.

- (1) Using the port 1A as a 3-bit I/O port

 The three bits of the port 1A can be assigned all inputs or all outputs. This assignment is performed by P1AGIO of the register file. Transferring data from and to this port is performed via the P1A (address 70H of BANK1).
- (2) Using port 1A as serial interface

 Serial interface or the I/O port (P1A₀, P1A₁, and P1A₂) is selected by SION.

5.6 INT PIN

This pin inputs an external interrupt request signal. At the rising edge of the signal input to this pin, the IRQ flag (RF: address 3DH, bit 1) is set.

The status of the pin can be read by using the INT flag (RF: address 0FH, bit 0). When a high level is input to the INT pin, the INT flag is set to "1"; when a low level is input, the INT flag is reset to "0" (refer to **Fig. 12-1 INT Flag**).

Bank Add- Port		Bit		Output	Read Contents		Written Contents		At Reset	
Dank	ress	Fort		DIL	Format	Input mode	Output mode	Input mode	Output mode	At Neset
			bз	Р0Аз						
	70H Port 0A	b ₂	P0A ₂	CMOS		Output latch			Input mode (w/pull-up	
	7011	I OIL OA	b ₁	P0A ₁	push-pull		Output lateri		resistor)	
			bo	P0A ₀						
			Ьз	P0B ₃						
	71H	Port 0B	b ₂	P0B ₂	N-ch		Pin status			
	' '''	1 OIL OB	b ₁	P0B ₁	open-drain					
0			bo	P0B ₀						Input mode
	72H Port	Port 0C	bз	P0C ₃						
			b ₂	P0C ₂	N-ch	Pin status		Output latch		
			b ₁	P0C ₁	open-drain					
			b ₀	P0Co						
		Port 0D	Ьз	P0D3						
			b ₂	P0D ₂	CMOS		Output latch			
			b ₁	P0D ₁ Note1	push-pull					
			b ₀	P0D ₀ Note1						
		Port 1A	Ьз	_						
1	70H		b ₂	P1A ₂ Note2	CMOS					
'	7011		b ₁	P1A ₁ Note2	push-pull					
			bo	P1A ₀ Note2						

Table 5-1 Relations between Port Registers and Pins

- **Notes 1.** When the NRZEN and TMOE flags are set to 1, the output latch is accessed both when these port pins are read and when they are written, regardless of whether the input or output mode is set.
 - 2. When the SIOEN flag is set to 1, these pins serve as serial interface pins. In this case, the statuses of the pins are read when the pins are read, regardless of the input or output mode. Data written to these pins is invalid.

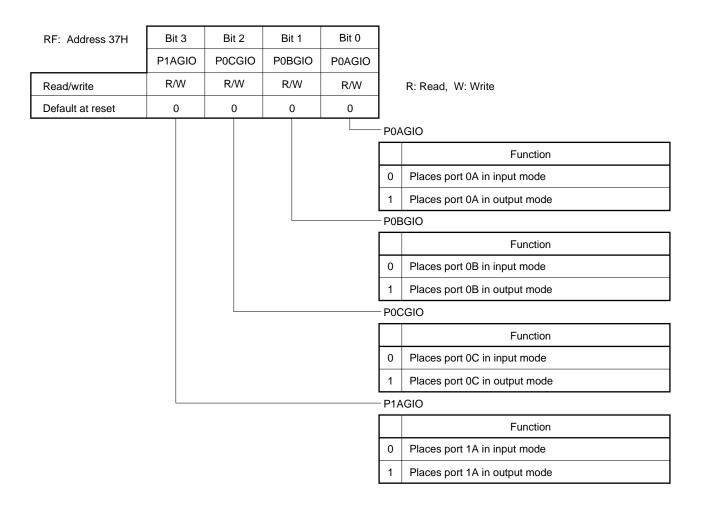


5.7 PORT CONTROL REGISTER

5.7.1 Switching between Input and Output of Grouped I/O Port

A grouped I/O port is a port whose four bits are assigned all inputs or all outputs at a time. Grouped I/O ports are P0A, P0B, P0C, P0D, and P1A. Their selection of inputs or outputs is performed by the following I/O control register. When the bits of each port are assigned from inputs to outputs, its output latch is output to the port.

Fig. 5-1 I/O Control Register for Grouped I/O Ports



5.7.2 Switching between Input and Output of Bitwise I/O Port

A bitwise I/O port is a port whose four bits are individually assigned inputs or output. The μ PD17207 supports only one bitwise I/O port: P0D. The bitwise input/output selection is performed by the following I/O control register. When the bits of this port are assigned from inputs to outputs, output latches of P0A, P0B, P0C, P0D, and P1A are output to the corresponding ports.

RF: Address 27H Bit 3 Bit 2 Bit 1 Bit 0 P0DBIO P0DBIO P0DBIO P0DBIO 2 3 1 0 R/W R/W R/W R/W Read/write R: Read, W: Write Default at reset 0 0 0 P0DBIO0 Function Places P0Do in input mode Places P0Do in output mode P0DBIO1 Function Places P0D1 in input mode 1 Places P0D1 in output mode P0DBIO2 Function Places P0D2 in input mode 1 Places P0D2 in output mode P0DBIO3 Function 0 Places P0D3 in input mode

Places P0D3 in output mode

Fig. 5-2 I/O Control Register for Bitwise I/O Ports

5.7.3 Switching among Port, Timer Output, and LED Output

The functions of port 0D (port, timer output, and LED output) are selected by settings of the TMOE and NRZEN bits of register file (TMOE for P0D₁ and NRZEN for P0D₀). Refer to **Fig. 5-3**.

5.7.4 Switching between Port and Serial Interface

The functions of port 1A (port and serial interface) are selected by settings of the SIOEN bit of register file. Refer to Fig. 5-3.

The mode of serial interface is controlled by SIOTS (bit 3 of address 22H), SIOHIZ (bit 2 of address 22H), SIOCK1 (bit 1 of address 22H), and SIOCK0 (bit 0 of address 22H) of register file.

Fig. 5-3 Input/Output Control Register for Selection of Port,
Timer Output, LED Output, and Serial Interface

RF: Address 23H	Bit 3	Bit 2	Bit 1	Bit 0	7		
	0	NRZEN	TMOE	SIOEN			
Read/write	R	R/W	R/W	R/W	R: Read, W: Write		
Default at reset	0	0	0	0			
					SIOEN		
					Function		
					0 Uses port 1A as I / O port		
					1 Uses port 1A as serial interface		
					-тмое		
					Function		
					0 Uses P0D1 as I / O port		
					1 Uses P0D1 external signel output for 8-bit timer's		
					NRZEN		
					Function		
					0 Uses P0Do as I / O port		
					1 Uses P0Do as LED output		

6. CLOCK GENERATOR CIRCUIT

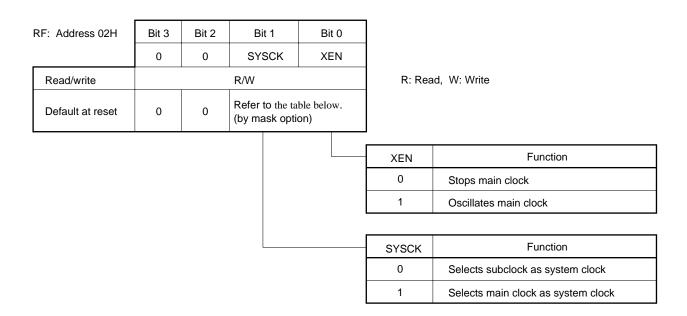
The μ PD17207 contains two types of oscillator circuits: the main clock (X) and the subclock (XT) oscillator circuits. The clock oscillated by either of the circuits can be used as the system clock.

Figure 6-1 shows the configuration of the system clock control register.

Whether the main or subclock is used as the system clock is specified by the SYSCK flag (RF: address 02H, bit 1). By resetting the XEN flag (RF: address 02H, bit 0), oscillation of the main clock can be stopped to reduce current dissipation.

To use the subclock, be sure to connect a 0.1- μ F capacitor to the V_{REG} pin to stabilize the oscillation of the subclock. When the subclock is not used (which is specified by mask option), connect the XT_{IN} pin to GND, and XT_{OUT} pin to V_{REG} pin.

Fig. 6-1 System Clock Control Register



Specifies n	Initial valu	e at reset	Remark	
Main clock	Subclock	SYSCK	XEN	
Used (USEX)	Used (USEX) Used (USEXT)		1	Value can be changed Note
	Not used (NOXT)	1	1	Fixed value (cannot be
Not used (NOX)	Used (USEXT)	0	0	changed in software)

Note SYSCK cannot be changed to 1 and XEN cannot be changed to 0.

*

6.1 SWITCHING SYSTEM CLOCK

The system clock can be switched between the main clock and subclock by using the SYSCK flag (RF: address 02H, bit 1) as shown in Fig. 6-1.

(1) Switching from main clock to subclock

The system clock can be changed from the main clock to subclock by resetting the SYSCK flag to "0". When NOXT is set by mask option, however, the subclock cannot be selected (SYSCK and XEN cannot be reset to "0").

Caution When turning on the power, make sure that a sufficient time elapses to stabilize the oscillation of the subclock (confirm that the IRQWTM flag (RF: address 3CH, bit 2) is set by the program at a specific cycle).

(2) Switching from subclock to main clock

The system clock can be changed from the subclock to the main clock by setting the SYSCK flag to "1". When NOX is set by mask option, however, the main clock cannot be selected (SYSCK and XEN cannot be set to "1").

Caution Before setting the SYSCK flag, make sure that at least 10 ms elapses after the XEN flag has been set to "1" so that the oscillation stabilizes.

6.2 MAIN CLOCK OSCILLATION CONTROL FUNCTION

When the subclock is used as the system clock, oscillation of the main clock can be controlled by manipulating the XEN flag (RF: address 02H, bit 0).

If the system clock is changed from the subclock to main clock (by setting the SYSCK flag) after the main clock is started (by setting the XEN flag), make sure that an oscillation stabilization time of about 10 ms elapses.

Caution Do not manipulate the XEN and SYSCK flags simultaneously (execute the POKE instruction twice).

7. 8-BIT TIMER AND REMOTE CONTROLLER CARRIER GENERATOR CIRCUIT

The 8-bit timer is mainly used to generate the leader pulse of the remote controller signal, and to output codes. Operations of timers are controlled by the GET instruction, the PUT instruction, and registers on the register file.

7.1 CONFIGURATION OF THE 8-BIT TIMER (WITH MODULO FUNCTION)

Figure 7-1 shows the functional block diagram of the 8-bit timer.

The 8-bit timer consists of an 8-bit counter (TMC), an 8-bit modulo register (TMM), a comparator which compares the contents of the timer with the contents of the modulo register, and a selector which selects a count clock of the 8-bit timer.

Starting/stopping of the 8-bit timer and resetting of the 8-bit counter are controlled by TMEN (bit 3 of address 33H) and TMRES (bit 2 of address 33H) of the register file. The count clock of the 8-bit timer is selected by TMCK1 (bit 1 of address 33H) and TMCK0 (bit 0 of address 33H) of the register file.

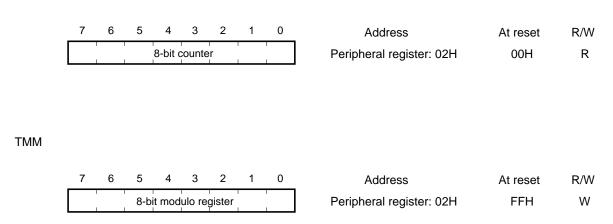
The contents of the 8-bit counter are read via the data buffer (DBF) by the GET instruction. The user cannot write any value in the 8-bit counter. The user can set a value in the modulo register by the PUT instruction via the data buffer (DBF).

The user cannot read the contents of the modulo register. As the 8-bit counter (TMC) and the modulo register (TMM) use an identical address, the CPU accesses the 8-bit counter to read and the 8-bit modulo register to write.

When the current count value of the counter and the value of the modulo register coincide with each other, the interrupt request flag (IRQTM: address 3EH, bit 0) is set, reflecting the output of the POD₁/TMOUT pin.

TMOUT is initialized and outputs a high level when TMRES is set.

TMC



Caution Do not clear TMM to 0 (IRQTM cannot be set.)

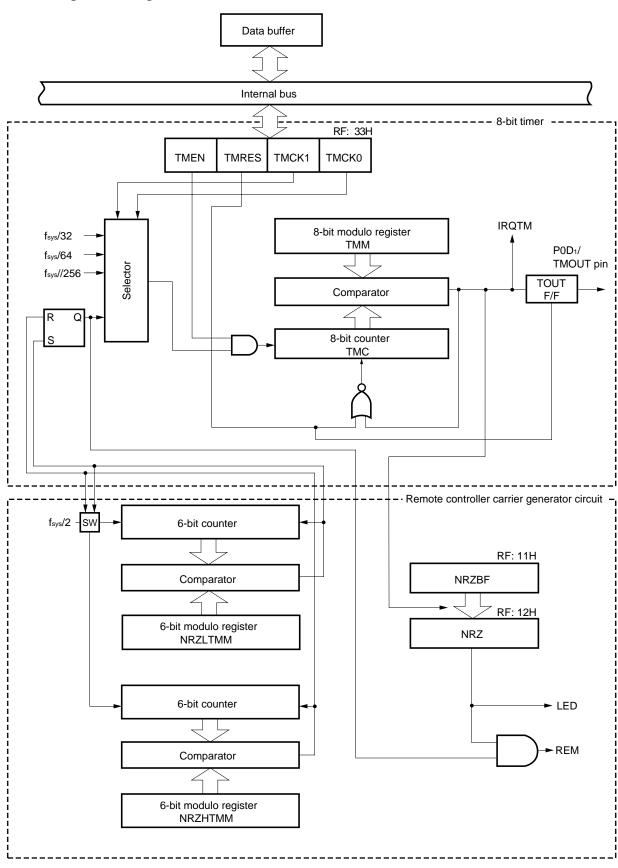


Fig. 7-1 Configuration of 8-Bit Timer and Remote Controller Carrier Generator Circuit

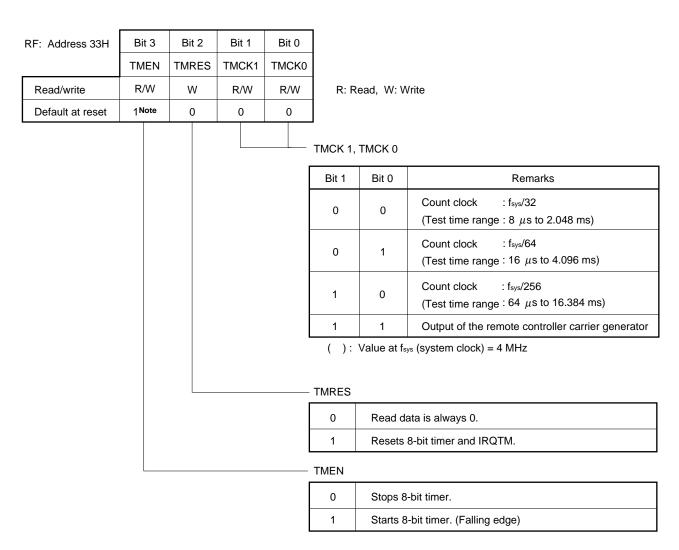
Remarks 1. fsys (system clock frequency): fx or fxT

2. TMM, TMC, NRZLTMM and NRZHTMM are peripheral register.



7.2 FUNCTION OF THE 8-BIT TIMER (WITH MODULO FUNCTION)

Fig. 7-2 8-Bit Timer Control Register



Note This bit is always set to 1 when the STOP mode is released.

7.3 REMOTE CONTROLLER CARRIER GENERATOR

The μ PD17207 is equipped with a circuit to generate carriers for the remote controller.

This circuit consists of a 6-bit counter, a modulo register (NRZHTMM) to determine an NRZ high-level period, a modulo register (NRZLTMM) to determine an NRZ low-level period, and a comparator.

A carrier duty factor and a carrier frequency are determined by the contents of these modulo registers. The values of the high- and low-level periods are set in the corresponding modulo registers via the data buffers (DBF).

A clock signal input to the 6-bit counter is obtained by dividing the frequency of the system clock signal by two (e.g, 2 MHz with a system clock of 4 MHzfx or 16.384 kHz with a system clock of $f_{XT} = 32.768$ kHz).

Modulo registers NRZHTMM and NRZLTMM are respectively resident on peripheral addresses 04H and 03H. These registers can be written by the PUT instruction and read by the GET instruction

7.3.1 Remote Controller Signal Output Control

The output of the REM pin which outputs carriers is controlled by NRZ (bit 0, address 12H of the register file), NRZBF (bit 0, address 11H of the register file), and an 8-bit timer.

While NRZ is "1", the REM pin outputs a carrier signal generated by the remote controller carrier generator. While NRZ is "0", the output of the REM pin is low. The contents of the NRZBF are automatically set in the NRZ flag by an interrupt signal generated by the 8-bit timer. When data is set in the NRZBF flag in advance, the status of the output of the REM pin varies in synchronization with the counting operation of the 8-bit timer.

The content of the NRZ flag is output to the LED pin. Namely, the LED pin outputs a high-level signal when NRZ is "1" and a low-level signal when NRZ is "0".

If the 8-bit timer generates an interrupt signal when the output of the REM pin is high, that is, when NRZ is "1" and a carrier signal is high, the output of the REM pin does not match the contents of NRZ until the carrier signal goes low.

This operation is required to hold the pulse width of high carrier pulses constant. (See Fig. 7-3.)

When NRZ is "0", the carrier generation circuit stops. In a system using the output of the remote controller carrier generator as a clock signal for the 8-bit timer, clock pulses are continuously supplied even after NRZ has become "0".

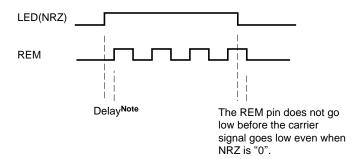


Fig. 7-3 Remote Controller Carrier Output

Note This is the value when $(TMCK1, TMCK0) \neq (1,1)$.

The value when (TMCK1, TMCK0) = (1, 1) differs depending on the manipulation of NRZ.

If NRZ is set to 1 by an instruction, the width of the first high-level pulse may be narrowed. If NRZ is set by means of transfer from NRZBF, the delay in the above chart is equivalent to the low-level pulse width of the carrier clock.

Fig. 7-4 Register to Control Output Signals of the Remote Controller

RF: Address 12H	Bit 3	Bit 2	Bit 1	Bit 0
	0	0	0	NRZ
Read / write	R	R	R	R/W
Default at reset	0	0	0	0

R: Read, W: Write

- NRZ

0	Outputs low-level signal to REM pin and low-level signal to LED pin.
1	Outputs carrier signal to REM pin and high-level signal to LED pin.

RF: Address 11H	Bit 3	Bit 2	Bit 1	Bit 0
	0	0	0	NRZBF
Read / write	R	R	R	R/W
Default at reset	0	0	0	0

R: Read, W: Write

NRZBF

0	NRZ buffer bit. Contents of this bit are transferred to NRZ by interrupt signal generated by 8-bit timer.
1	to NRZ by interrupt signal generated by 8-bit timer.

Fig. 7-5 Input/Output Control Register for Port/Timer Output, LED Output, and Serial Interface

					_
RF: address 23H	Bit 3	Bit 2	Bit 1	Bit 0	
	0	N R Z E N	T M O E	S I O E N	
Read/write	R	R/W	R/W	R/W	Read = R, Write = W
Initial value at reset	0	0	0	0	
					TMOE
					Function
					0 Uses P0D ₁ as I/O port pin
					1 Uses P0D ₁ as external signal output pin of 8-bit timer
					NRZEN
					Function
					0 Uses P0D₀ as I/O port pin
					1 Uses P0D₀ as LED output pin

7.3.2 Setting a Carrier Frequency and a Duty Factor

Frequency division ratio ℓ necessary for obtaining carrier frequency fc can be calculated by the following expression where the frequency of main clock (X) is fx.

$$\ell = fx/(2 x fc)$$
.

Set the following values to the modulo register to divide $\,\ell\,$ into duty factors m: n.

High-level period setting value (NRZHTMM) = $\ell \times m/(m + n) - 1$

Low-level period setting value (NRZLTMM) = $\ell \times n/(m + n) - 1$

Example: Where fx = 4 MHz, fc = 38 kHz, and duty factor = 1/3 (m:n = 1:2)

 $\ell = 4 \text{ MHz}/(2 \times 38 \text{ kHz}) = 52.6$

Therefore, the values of the modulo registers are as follows:

High-level period (NRZHTMM) ≒ 17 (11H)

Low-level period (NRZLTMM) = 34 (22H)

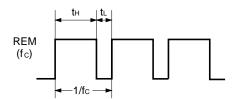
Calculating the carrier frequency with these values,

 $fc = fx/(2 x \ell) = 4 MHz/(2 x 53) = 37.74 kHz$

(where $\ell = (17 + 1) + (34 + 1) = 53$)

Table 7-1 Example of Carrier Frequency (fx = fsys = 4 MHz)

Set Value		tн (μs)	t∟ (μs)	1/fc (μs)	fc (kHz)	Duty	
NRZHTMM	NRZLTMM	ιπ (μ3)	ιι (μο)	1710 (μ3)	10 (KH2)	Duty	
00H	00H	0.5	0.5	1.0	1000	1/2	
01H	02H	1.0	1.5	2.5	400	2/5	
04H	04H	2.5	2.5	5.0	200	1/2	
09H	09H	5.0	5.0	10.0	100	1/2	
0FH	10H	8.0	8.5	16.5	60.6	1/2	
0FH	21H	8.0	17.0	25.0	40.0	1/3	
11H	21H	9.0	17.0	26.0	38.5	1/3	
11H	22H	9.0	17.5	26.5	37.7	1/3	
19H	35H	13.0	27.0	40.0	25.0	1/3	
3FH	3FH	32.0	32.0	64.0	15.6	1/2	



7.3.3 Countermeasures against Noise during Transmission (Carrier Output)

When a signal is transmitted from the transmitter of a remote controller, a peak current of 0.5 to 1 A may flow through the infrared LED. Since two batteries are usually used as the power source of the transmitter, several Ω of equivalent resistance (r) exists in the power source as shown in Fig. 7-6. This resistance increases from 10 to 20 Ω if the supply voltage drops to 2 V. While the carrier is output from the REM pin (while the infrared LED lights), therefore, a high-frequency noise may be generated on the power lines due to the voltage fluctuation that may take place especially during switching.

To minimize the influence on the microcontroller of this high-frequency noise, take the following measures:

- 1 Separate the power lines of the microcontroller from the power lines of the infrared LED with the terminals of the batteries at the center. Use thick power lines and keep the wiring short.
- ② Locate the oscillator as close as possible to the microcontroller and shield it with GND lines (as indicated by the portion inside the dotted line in the figure below).
- 3 Locate the capacitor for stabilization of the power supply closely to the power lines of the microcontroller. Also, use a capacitor to eliminate high-frequency noise.
- 4 To prevent data from changing, do not execute an interrupt that requires read/write processing and stack, such as key scan interrupt, and the CALL/RET instruction, while the carrier is output.
- (5) To improve the reliability in case of program hang-up, use the watchdog timer (connect the WDOUT and RESET pins).

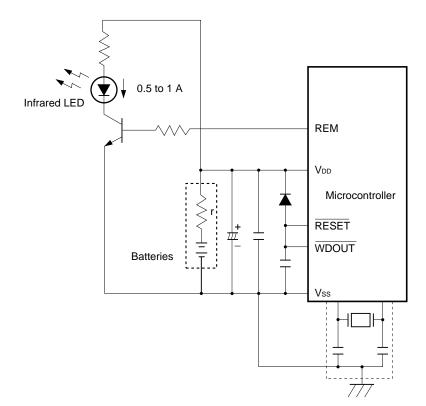


Fig. 7-6 Example of Countermeasures against Noise

- Remarks 1. The INT and RESET pins are multiplexed with test pins (refer to 3.4 NOTES ON USING RESET AND INT PINS).
 - 2. In this figure, the RESET pin is connected to a pull-up resistor by mask option.

WATCH TIMER/WATCHDOG TIMER

The watch timer is used to generate a watch interrupt signal and a signal to reset the watchdog timer.

8.1 CONFIGURATION OF WATCH TIMER/WATCHDOG TIMER

Figure 8-1 shows the functional block diagram of the watch timer/watchdog timer.

As shown in Fig. 8-1, the watch timer consists of two selectors, A and B, and a frequency divider. Selector A selects the divided output $(fx/2^7)$ of the 32.768-kHz subclock oscillator (XT) output or of the main clock oscillator (X) output as the source clock by using mask option. Selector B selects a frequency to be used as an interrupt signal. The divider creates a frequency of the source clock.

Resetting the watch timer and the operation of selector B is controlled by WTMRES (address 03H, bit 1) and WTMMD (address 03H, bit 2) of the register file.

The watchdog timer is reset by WDTRES (address 03H, bit 3) of the register file.

If the subclock (fxT) is the source clock, the watch timer count cannot be stopped. Therefore, the subclock does not stop but continues to oscillate even when the CPU is in the STOP mode.

If the divided output of the main clock $(fx/2^7)$ is the source clock (when the subclock is not used), the watch timer stops when the CPU is set in the STOP mode.

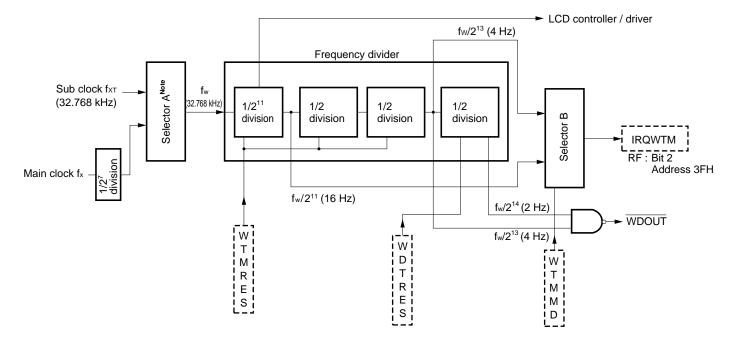


Fig. 8-1 Configuration of Watch Timer/Watchdog Timer

Remark () indicates the value when the subclock is used.

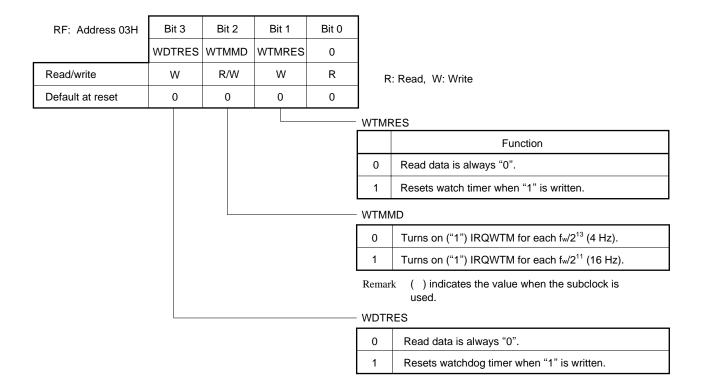
Note The source clock of the watch timer/watchdog timer is fixed as follows by mask option:

- (1) When subclock is selected by mask option The source clock is fixed to the subclock.
- (2) When subclock is not selected by mask option The source clock is fixed to fx/2⁷



8.2 FUNCTION OF WATCH TIMER/WATCHDOG TIMER

Fig. 8-2 Watch Timer/Watchdog Timer Control Register



8.3 WATCHDOG TIMER OPERATION TIMING

Unless the watchdog timer is reset in a fixed time, the WDOUT pin outputs a low level. By connecting the WDOUT pin to the RESET pin, a program hang-up can be detected by the watchdog timer.

To reset the watchdog timer, set WDTRES (WDTRES = 1).

To disable hang-up detection by the watchdog timer when the subclock is used, program so that WDTRES is set at intervals of approximately 340 ms or less.

- Cautions 1. The watchdog timer cannot be reset in the shaded range in Fig. 8-3. Therefore, set the watchdog timer before both the fw/2¹³ and fw/2¹⁴ signals go high.
 - 2. For further information on the WDOUT pin, also refer to 14. RESET.

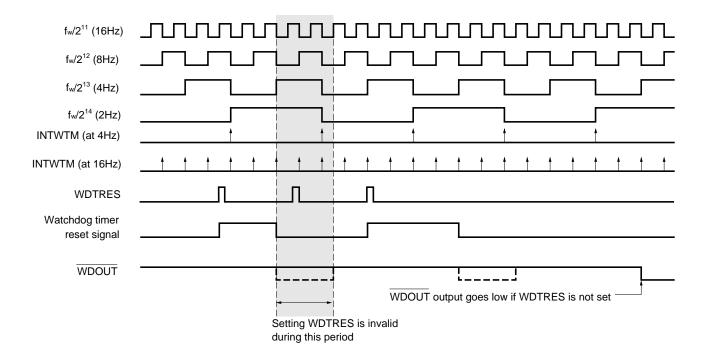


Fig. 8-3 Watchdog Timer Operation Timing

Remark Figures in the parentheses indicate the value when using the subclock.

★ 9. A/D CONVERTER

The μ PD17207 has an 8-bit successive approximation A/D converter.

This A/D converter can be used in the following two modes.

Mode	Description			
A/D conversion mode	Converts analog voltage input to one pin into digital signal			
Compare mode	Compares analog voltages input to two pins			

9.1 CONFIGURATION OF A/D CONVERTER

The 8-bit A/D converter consists of a selector that selects an input pin, analog switch, control circuit, 8-bit resistor string D/A converter, and comparator.

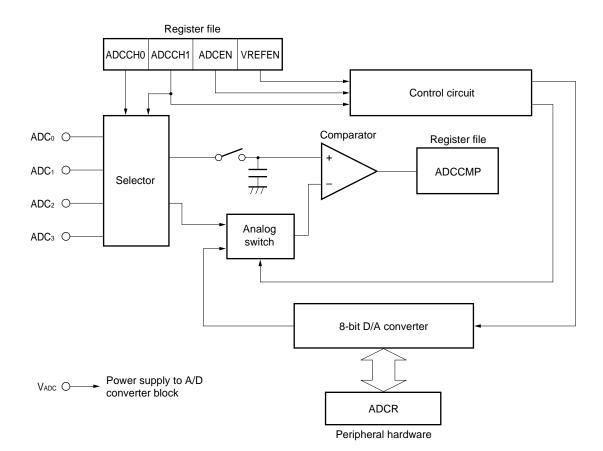


Fig. 9-1 Block Diagram of A/D Converter

9.2 FUNCTION OF A/D CONVERTER

9.2.1 Function in A/D Conversion Mode

In the A/D conversion mode, the A/D converter compares an analog voltage input to one of the pins ADC3 through AD0 with an internal reference voltage and outputs the result to ADCCMP on the register file.

The pin from which an analog voltage is to be input is selected by the operation mode register (refer to **Figure 9-2**). Two or more pins cannot be selected for A/D conversion at the same time.

The internal reference voltage is created by the 8-bit D/A converter based on the data set by the internal reference voltage setting register (ADCR). The 8-bit D/A converter can create 256 values of the internal reference voltage.

By selecting an internal reference voltage and executing successive approximation in software, the input analog voltage can be converted into a digital value.

Ор	Operation Mode Register			Selected	Function		
VREFEN	ADCEN	ADCCH1	ADCCH0	Input Pin			
1	1	0	0	ADC ₀	Compares analog voltage input to ADC ₀ pin with internal reference voltage		
		0	1	ADC ₁	Compares analog voltage input to ADC ₁ pin with internal reference voltage		
		1	0	ADC ₂	Compares analog voltage input to ADC2 pin with internal reference voltage		
		1	1	ADC ₃	Compares analog voltage input to ADC ₃ pin with internal reference voltage		

9.2.2 Function in Compare Mode

In the compare mode, analog voltages input two of the pins ADC₃ through ADC₀ are compared with each other and the result is output to ADCCMP in the register file. The two pins from which analog voltages are to be input are selected by the operation mode register (refer to **Figure 9-2**).

Two pairs of pins can be selected: pins ADC₂ and ADC₀, pins or ADC₃ and ADC₁. Both pairs of pins cannot be selected at the same time.

Ор	Operation Mode Register			Selected	Function		
VREFEN	ADCEN	ADCCH1	ADCCH0	Input Pin	i dilototi		
0	0	1	0	ADC ₂	Compares analog voltages input to ADC2 and ADC0 pins		
		1	1	ADC ₃ ADC ₁	Compares analog voltages input to ADC ₃ and ADC ₁ pins		



9.3 CONTROL REGISTERS OF A/D CONVERTER

9.3.1 Operation Mode Register

The operation mode register selects the operation mode and analog input pin(s) of the A/D converter by using the flags in the register file as illustrated below.

Fig. 9-2 Operation Mode Register

					_
RF: address 21H	Bit 3	Bit 2	Bit 1	Bit 0	
	V R E F E N	A D C E N	A D C C H 1	A D C C H 0	
Read/write		R/	W		Read = R, write = W
Initial value at reset	0	0	0	0	
					•
					. S

\/DEEEN	ADOEN	1000111	4000110	Operation	Selected analog input pin		
VREFEN	ADCEN	ADCCH1	ADCCH0	mode	+side of internal comparator	—side of internal comparator	
0	0	1	0	Compare	ADC ₂ pin	ADC₀ pin	
0	0	1	1	Compare	ADC₃ pin	ADC ₁ pin	
1	1	0	0	A/D conversion	ADC₀ pin	(Internal reference voltage)	
1	1	0	1	A/D conversion	ADC ₁ pin	(Internal reference voltage)	
1	1	1	0	A/D conversion	ADC ₂ pin	(Internal reference voltage)	
1	1	1	1	A/D conversion	ADC₃ pin	(Internal reference voltage)	
0 0 0 Don Care				Operation stops	None		
	Oth	ners		Setting prohibited	Undefined		

Caution Set the operation stop mode to reduce the current consumption when the A/D converter is not used.

9.3.2 Internal Reference Voltage Setting Register (ADCR)

The internal reference voltage setting register (ADCR) is an 8-bit register that sets the reference voltage of the converter. This register is allocated to the peripheral hardware. Data is written to the ADCR via data buffer (DBF). The 8-bit data set to DBF0 and DBF1 is written to the ADCR by using the "PUT ADCR, DBF" instruction.

9.3.3 Compare Result Register

The result of comparison by the converter is stored to the ADCCMP flag in the register file.

Fig. 9-3 Compare Result Register

RF: address 20H Bit 3 Bit 2 Bit 1 Bit 0 0 0 0 0 C C M P Read/write R Initial value at reset 0 0 0 0					
0 0 0 0 C C M P Read/write R	RF: address 20H	Bit 3	Bit 2	Bit 1	Bit 0
		0	0	0	D C C M
Initial value at reset 0 0 0 0	Read/write		F	₹	
	Initial value at reset	0	0	0	0

Read = R

ADCCMP

[In compare mode]

ADCCMP	Result of comparison
0	ADC ₂ voltage < ADC ₀ voltage
	ADC ₃ voltage < ADC ₁ voltage
4	ADC₂ voltage ≥ ADC₀ voltage
ļ	ADC ₃ voltage ≥ ADC ₁ voltage

[In A/D conversion mode]

ADCCMP	Result of comparison
0	ADCn voltage < internal reference voltage
1	ADC _n voltage ≥ internal reference voltage

(n = 0 to 3)

9.4 OPERATION IN A/D CONVERSION MODE

The timing necessary for A/D conversion differs depending on whether the main clock or subclock is selected as the system clock.

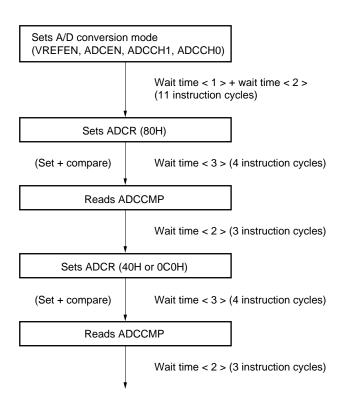
(1) When main clock is selected as system clock

The following wait times must be set in software in the A/D conversion mode.

Wait time <1>: Time of transition from operation stop mode to A/D conversion mode (8 instruction cycles)

Wait time <2>: Wait time until value can be set to ADCR (3 instruction cycles)

Wait time <3>: Wait time until compare result register can be read (4 instruction cycles)



An example of a program for A/D conversion when the main clock is selected is shown below.

CMPVAL ADCNV:	DAT	80H	; Reference voltage =VADC \times CMPVAL/256
	BANKO INITFLG MOV MOV REPT NOP ENDR	VREFEN,ADCEN,NOT ADCCH1,NOT ADCCH0 DBF0, #CMPVAL AND 0FH DBF1, #CMPVAL SHR 4 and 0FH 9	; Starts sampling of input to ADCo Waits for at least 11 instruction cycles until ADCR is set
	PUT NOP NOP NOP NOP	ADCR,DBF	; Holds input and starts comparison Waits for at least 4 instruction cycles until ADCCMP is checked
	PEEK	WR,.MF.ADCCMP SHR 4 AND 0FFFH	; Reads result of comparison (starts sampling)
	MOV MOV NOP	DBF0, #CMPVAL AND 0FH DBF1, #CMPVAL SHR 4 AND 0FH	Waits for at least 3 instruction cycles until ADCR is set
	PUT NOP NOP NOP	ADCR, DBF	; Holds input and starts comparison Waits for at least 4 instruction cycles until ADCCMP is checked
	PEEK	WR,.MF.ADCCMP SHR 4 AND 0FFFH	; Reads result of comparison (starts sampling)

(2) When subclock is being selected as system clock

Unlike when the main clock is selected, the wait times do not need to be set in software when the subclock is selected. Setting the A/D conversion mode, ADCR, and reading ADCCMP are completed in one instruction cycle, respectively.

An example of a program for A/D conversion when the subclock is selected is shown below.

CMPVAL	DAT	80H	; Reference voltage = $V_{ADC} \times CMPVAL/256$
ADCNV:			
	BANK0		
	INITFLG	VREFEN,ADCEN,NOT ADCCH1,NOT ADCCH0	; Starts sampling a voltage input to the ADCo
			pin.
	MOV	DBF0,#CMPVAL AND 0FH	
	MOV	DBF1,#CMPVAL SHR 4 AND 0FH	
	PUT	ADCR,DBF	; Holds the Input and starts comparison
	PEEK	WR,.MF.ADCCMP SHR 4 AND 0FFFH	; Reads the result of comparison (and starts
			sampling).

9.5 OPERATION IN COMPARE MODE

In the compare mode, the result of comparison stored to ADCCMP is read and then the next comparison is immediately performed. Therefore, comparison is executed successively and the ADCCMP flag is rewritten accordingly.

The timing necessary for compare mode differs depending on whether the main clock or subclock is selected as the system clock.

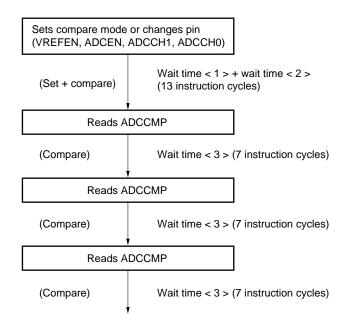
(1) When main clock is selected as system clock

The following wait times must be set in software in the compare mode.

Wait time <1>: Time of transition from operation stop mode to compare mode (10 instruction cycles)

Wait time <2>: Wait time until compare result register can be read (first time only) (3 instruction cycles)

Wait time <3>: Wait time until compare result register can be read (second time and onward) (7 instruction cycles)



An example of a program in the compare mode when the main clock is selected is shown below.

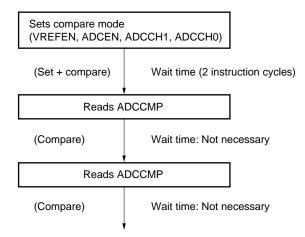
COMPARE:

INITFLG	NOT VREFEN,NOT ADCEN,ADCCH1,ADCCH0	;	Starts comparing voltages of ADC ₃ and ADC ₁
REPT NOP	13	}	Waits for duration of 13 instruction cycles
ENDR	WE AROUND OUR AAND OFFELL	J	or more until comparison ends
PEEK REPT	WR,.MF.ADCCMP SHR 4 AND 0FFFH 7	; }	Reads result of comparison
NOP		Į	Waits for duration of 7 instruction cycles or more until comparison ends
ENDR	WE AR ADOMEDOUR AND SEEL	J	
PEEK	WR,.MF.ADCCMP SHR 4 AND 0FFFH	;	Reads result of comparison

(2) When subclock is selected as system clock

The following wait times must be set in software during compare operation.

Wait time: Time of transition from operation stop mode to compare mode (2 instruction cycles)



An example of a program in the compare mode when the subclock is selected is shown below.

COMPARE:

INITFLG	NOT VREFEN,NOT ADCEN,ADCCH1,ADCCH0	;	Starts comparing voltages on ADC ₃
			and ADC ₁
NOP]	Waits for duration of 2 instruction cycles
NOP			or more until comparison ends
PEEK	WR,.MF.ADCCMP SHR 4 AND 0FFFH	;	Reads result of comparison
PEEK	WRMF.ADCCMP SHR 4 AND 0FFFH	:	Reads result of comparison



10. SERIAL INTERFACE

Serial interface consists of an 8-bit shift register, a 4-bit shift mode register, and a 3-bit counter, and transmits data in series to and from the bus.

10.1 SERIAL INTERFACE FUNCTION

10.1.1 8-bit Data Transfer in Synchronization with Clocks (Simultaneous transmission and reception)

Input and output of serial data on serial interface is controlled by the serial clock (\overline{SCK}) signal. At the falling edge of the SCK signal, the most significant bit of the shift register is output from the SO pin (pin 59; also used as P1A₁). At the rising edge of the SCK signal, the contents of the shift register are shifted left by one bit and, at the same time, data input via the SI pin (pin 60; also used as P1A₂) is set in the least significant bit of the shift register.

The 3-bit counter counts serial clock pulses. Each time the counter counts eight clock pulses (each time serial data of 8 bits is transferred), the IRQSIO flag (bit 3, address 3BH) of the register file is turned on ("1") to make an interrupt request.

10.1.2 8-bit Data Reception in Synchronism with Clocks (High-impedance SO output)

This operation is basically the same as the above operation except that the SI pin (pin 59; also used as P1A₁) goes into a high-impedance state and does not output serial data. Therefore, the SO pin can be used as a port (P1A₁).

10.2 SERIAL INTERFACE OPERATION

10.2.1 Serial Interface Operation Modes

P1A₂/SI (pin 60), P1A₁/SO (pin 59), and P1A₀/SCK (pin 58) are placed in Serial Interface mode when the SIOEN flag (bit 0, address 23H) of the register file is turned on ("1"). These pins can be used as port pins when the SIOEN flag is off ("0"). As this operation mode disables transfer of serial data, the shift register can be used as an 8-bit register.

10.2.2 Serial Operation Mode

The serial operation mode is determined by the status of the SIOHIZ flag (bit 2, address 22H) of the register file. When this flag is off ("0"), a clock-synchronous 8-bit transmission/reception mode is set. When this flag is on ("1"), a clock-synchronous 8-bit reception mode is set. Figure 10-1 shows shift timing waveforms. The only difference between these two modes is whether the SO pin (pin 59; also used as P1A₁) goes into a high-impedance state.

In transmission of serial data, data to be transmitted is set in the shift register SIOSFR (peripheral address 01H) via the data buffer (DBF) by an PUT instruction, and the SIOTS flag (bit3, address 22H) of the register file is turned on ("1"). Thus serial data trasfer starts. When 8 bits of data are transferred, the SIOTS flag is automatically turned off ("0") and the IRQSIO flag (bit 3, address 3BH) of the register file is turned on ("1") to generate an interrupt. If generation of an interrupt is disabled, the end of transfer can be indicated by the SIOTS and IRQSIO flags.

Reception of serial data is basically the same as the transmission of serial data except that data is output from the SO pin.

The μ PD17207 supports four kinds of clock signals (three internal clocks and one external clock) to be selected as the serial clock source. These clock signals are selected by SIOCK1 (bit 1, address 22H) and SIOCK0 (bit 0, address 22H) of the register file.

If one of the three internal clock signals is selected as the serial clock source, it is supplied to serial interface when the SIOTS flag turns on ("1"). The clock controls input/output of serial data and is output from the \overline{SCK} pin (pin 58; also used as P1A0). When eight clock pulses are supplied to the serial interface, the \overline{SIOTS} flag is automatically turned off ("0") and the supply of clock pulses to the serial interface is stopped. Then, the \overline{SCK} pin is held high. At this time, the IRQSIO flag (bit 3, address 3BH) of the register file is turned on ("1").

If the external clock is selected, the clock pulses supplied from the SCK pin are supplied to serial interface when the SIOTS flag is turned on ("1"). Similarly, when eight clock pulses are supplied to the serial interface, the SIOTS flag is automatically turned off ("0") and the supply of clock pulses to the serial interface is stopped. At this time, the IRQSIO flag (bit 3, address 3BH) of the register file is turned on ("1").

The IRQSIO flag is automatically reset to "0" when the SIOTS flag is turned on ("1").

To forcibly stop transfer of serial data, turn on the SIOTS flag manually. Note, however, that data transfer cannot be resumed from the point at which the transfer has been forcibly stopped.

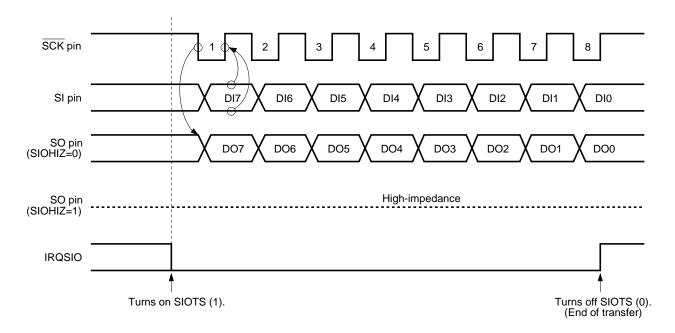


Fig. 10-1 Shift Timing Waveforms

Remark DI: Serial data input

DO: Serial data output

Fig. 10-2 Input/Output Control Register for Selection of Port, Timer Output, LED Output, and Serial Interface

RF: Address 23H	Bit 3	Bit 2	Bit 1	Bit 0	
	0	NRZEN	TMOE	SIOEN	
Read/write	R	R/W	R/W	R/W	
Default at reset	0	0	0	0	

R: Read, W: Write

SIOEN

	Function				
0	Uses Port 1A as I / O port.				
1	Uses Port 1A as serial interface.				

Fig. 10-3 Serial Interface Control Register

RF: Address 22H	Bit 3	Bit 2	Bit 1	Bit 0					
	SIOTS	SIOHIZ	SIOCK1	SIOCK0					
Read/write		R	/W		R: Read, W: Write				
Default at reset	0	0	0	0					
					SIOCK1, S	IOCK0			
					SIOCK1,	SIOCK0	Selects Serial Clock		
					0	0	External clock		
					0	1	f _{sys} /16		
					1	0	f _{sys} /128		
					1	1	f _{sys} /1024		
					- SIOHIZ	(f _{sys} : system	n clock. fx or fxt)		
							SO Pin Status		
					0 Seria	al data outp	ut		
					1 High	-impedance	status		
				OTS ead]					
						Functi	ion		
			0				om being shifted. on input from port.		
			1	Shifts contents of shift register by serial clock pulses. Pin status can be read by instruction input from port.					
			[/\	/rite]					
						- Functi			

	Function								
0	Forcibly stops transfer of serial data. Data transfer cannot be resumed from where it has been stopped. 3-bit counter is cleared.								
1	Can be set by PUT instruction only. Transfer of serial data starts. Resets IRQSIO flag (to "0"). This bit is automatically reset to "0" after transfer of data ends.								

Caution Be sure to select a serial clock signal before starting transfer of serial data. Never set them at the same time.

Remark At the end of transfer of 8-bit serial data, the IRQSIO flag (bit 3, address 3BH of the register file) is turned on ("1") and an interrupt request occurs.

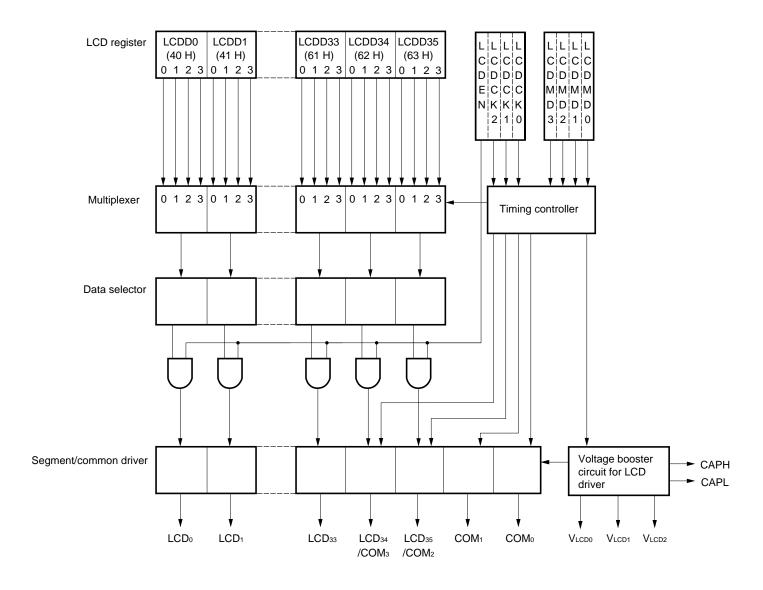
11. LCD CONTROLLER/DRIVER

11.1 CONFIGURATION OF LCD CONTROLLER/DRIVER

The μ PD17207 is equipped with an LCD controller which generates segment and common signals according to the data set to the LCD register and a segment/common driver which can directly drive the LCD panel.

Figure 11-1 shows the functional block diagram of the LCD controller/driver.

Fig. 11-1 Block Diagram of LCD Controller/Driver



11.2 FUNCTIONS OF LCD CONTROLLER/DRIVER

The LCD controller/driver of the μ PD17207 features the following:

- (1) Automatically reads the LCD register and generates segment signals and common signals.
- (2) Three display modes available:
 - Display mode 1: 1/2-duty, 1/3-bias
 - Display mode 2: 1/3-duty, 1/3-bias
 - Display mode 3: 1/4-duty, 1/3-bias
- (3) Four frame frequencies available in each display mode.
- (4) Since a voltage booster circuit for LCD driver is used, constant output voltage not affected by the fluctuation in the supply voltage.
- (5) The LCD register which is not used for display can be used as ordinary data memory.

Table 11-1 shows the maximum number of pixels available in each display mode.

Table 11-1 Maximum Number of Pixels Displayed

Mode	Duty	Common Signal Maximum Number of Pixels			
1	1/2	COM ₀ , COM ₁	72 (36 segment signals by 2 common signals)		
2	1/3 COM ₀ , COM ₁ , COM ₂		105 (35 segment signals by 3 common signals)		
3	1/4	COM ₀ , COM ₁ , COM ₂ , COM ₃	136 (34 segment signals by 4 common signals)		

11.3 DISPLAY MODE REGISTER

The Display Mode register selects a display mode of the LCD controller/driver, a frame frequency, and LCD on/ off status.

The display mode register consists of LCDMD0 to LCDMD3 (address 32H of register file) for selection of a display mode, LCDEN (bit 3, address 31H of the register file) for selection of the LCD on/off status, and LCDCK0 to LCDCK2 (bit 2 to bit 0, address 31H of the register file) for selection of a frame frequency.

Fig. 11-2 Display Mode Register

RF: 32H	Bit 3	Bi	Bit 2		Bit 1		t 0
	LCDME	3 LCD	MD2	LCDI	MD1	LCDI	MD0
Read/write	R R R		R/	W	R/	W	
Default at reset	0	()	C)	1	I

Read = R, Write = W

LCDMD0 - LCDMD3

LCDMD3	LCDMD2	LCDMD1	LCDMD0	Display Mode	
0	0	0	0	Stops the LCD voltage booster circuit. Note	
0	0	0	1	Display mode 1 (1/2 duty)	
0	0	1	0	Display mode 2 (1/3 duty)	
0	0	1	1	Display mode 3 (1/4 duty)	
	Oth	ners	Inhibited		

Note All segment and common signals are at a preset voltage (VLCDO)

Fig. 11-3 LCD Controller/Driver Control Register

RF: 31H	Bit 3	Bit 2	Bit 1	Bit 0						
	LCDEN	LCDCK2	LCDCK1	LCDCK0						
Read/write	R/W	R	R/W	R/W	Read = R, Write = W					
Default at reset	0	0	0	0						
					LCDCK0 – LCDCK2					
						Frame Frequency				
					LCDCK2	LCDCK1	LCDCK0	Mode 1 1/2 duty	Mode 2 1/3 duty	Mode 3 1/4 duty
					0	0	0	f _w /(2 × 2 ⁶) [256 Hz]	f _w /(3 × 2 ⁶) [170 Hz]	$f_w/(4 \times 2^6)$ [128 Hz]
					0	0	1	f _w /(2 × 2 ⁵) [512Hz]	fw/(3 × 2 ⁵) [341.3 Hz]	f _w /(4 × 2 ⁵) [256 Hz]
					0	1	0	f _w /(2 × 2 ⁸) [64 Hz]	f _w /(3 × 2 ⁸) [42.6 Hz]	f _w /(4 × 2 ⁸) [32 Hz]
					0	1	1	$f_{w}/(2 \times 2^{7})$ [128 Hz]	$f_{\rm w}/(3 \times 2^7)$ [85.3 Hz]	$f_w/(4 \times 2^7)$ [64 Hz]

Remark 1. $f_w = f_{xt}$ or $f_x/2^7$

Others

2. []: Frequency for $f_w = 32.768 \text{ kHz}$

- LCDEN

LCDEN	Function					
0	Turns off the LCD display. (all segment signals are on unselected)					
1	Turns on LCD display.					

Inhibited

- Cautions 1. The LCD clock is supplied from the watch timer; therefore, the LCD flickers if the watch timer is reset during display. Do not reset the watch timer during display.
 - If the main clock and subclock are used, the source clock of the LCD is the subclock. When
 the power is switched on, therefore, the LCD may flicker until the oscillation of the subclock
 stabilizes. Make sure that a sufficiently long time elapses until the oscillation stabilizes
 before turning on the LCD (it is recommended that all-light mode be used immediately after
 power application).
 - 3. The LCD display voltages (VLCD1, And VLCD2) become undefined momentarily on turning ON/OFF power, reset, and setting or clearing the STOP mode. As a result, the LCD display may be turned ON (blurring of the LCD). This symptom is conspicuous when only the main clock is used or if the capacitance at the LCD display side is too high. To prevent this, take the following measures.
 - Provide wait time of 1 frame cycle or longer until the voltage booster circuit is stopped by the display mode register after the LCD display has been turned off.
 - Provide wait time of around 2 ms after the voltage booster circuit has been stopped until the STOP instruction is executed.

11.4 LCD REGISTER

The LCD register is resident on addresses 40H to 63H (LCDD0 to LCDD35) of BANK 0.

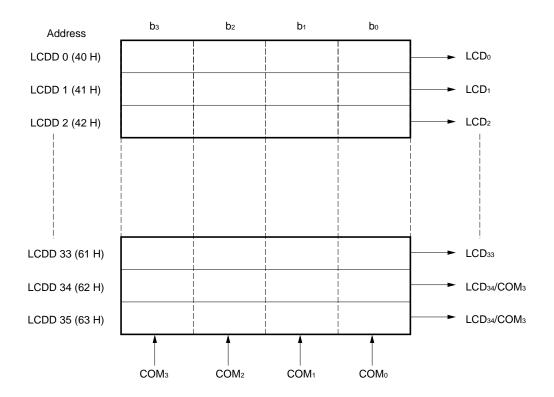
The LCD controller/driver reads the LCD register independently of the operation of the CPU.

The LCD controller controls segment signals according to the data of the LCD register.

The data memory area which is not used for LCD display can be used as ordinary data memory.

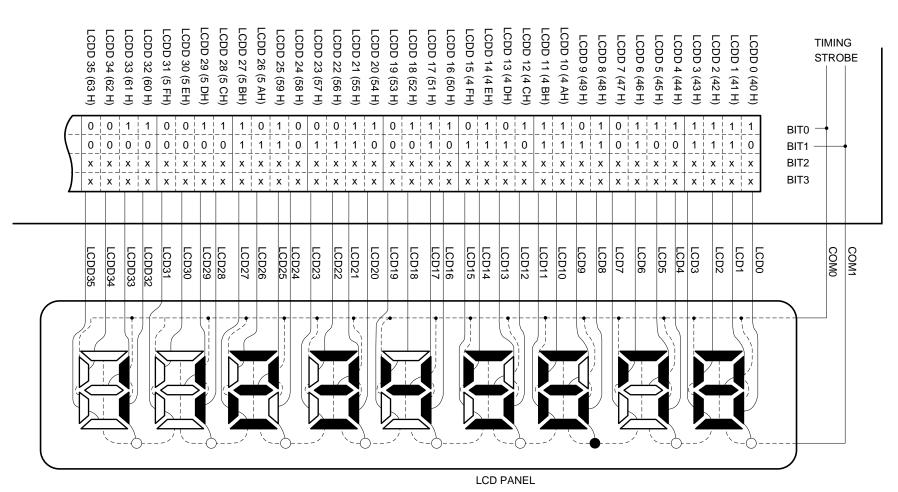
Figure 11-4 shows the assignment of segment outputs to bits of the LCD register.

Fig. 11-4 Assignment of Common Signals and Segment Signals to LCD Register



NEC





x: Any value because of secondary time sharing display.

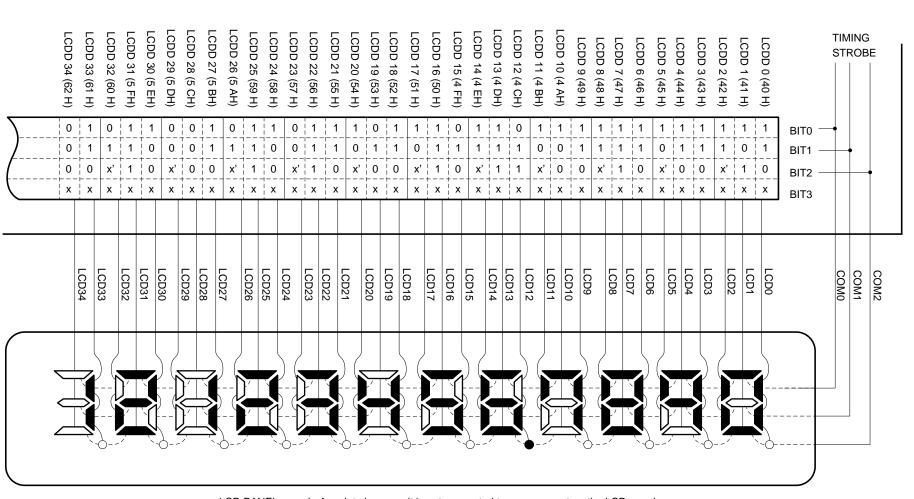


Fig. 11-6 Wiring Example of Tertiary Time Sharing LCD Panel

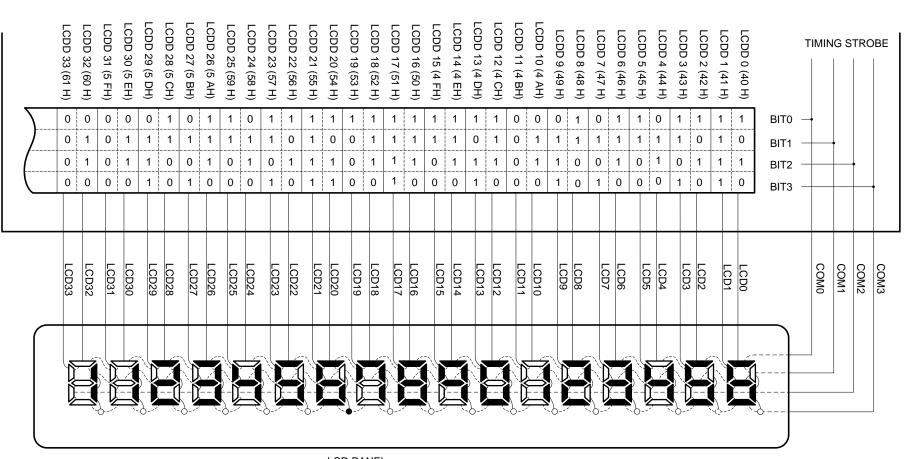
LCD PANEL

x': Any data because it is not connected to any segment on the LCD panel.

x: Any data because of tertiary time-sharing disply.

NEC

Fig. 11-7 Wiring Example of Quarternary Time Sharing LCD Panel



LCD PANEL

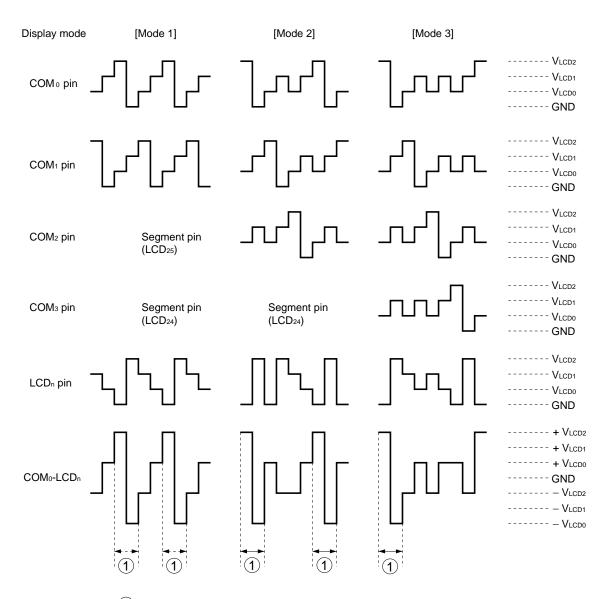
11.5 SEGMENT SIGNALS AND COMMON SIGNALS

Segment pins LCD₀ to LCD₃₅ are connected to the corresponding front electrodes of the LCD panel and common pins COM₀ to COM₃ are connected to corresponding rear electrodes of the LCD panel. The LCD panel lights when the potential difference between its segment and common signals goes beyond a preset voltage.

The LCD panel is driven on an AC voltage because it degrades quickly if a DC voltage is continuously applied between its segment and common pins.

Figure 11-8 to Fig. 11-10 shows waveforms of segment and common signals in each display mode.

Fig. 11-8 Common and Segment Waveforms in Each Display Mode (for LCDEN = 1)



(1): The LCD stripe lights here (by an LCD selection voltage).

Fig. 11-9 Common and Segment Waveforms for LCDEN = 0 (LCD Display Off)

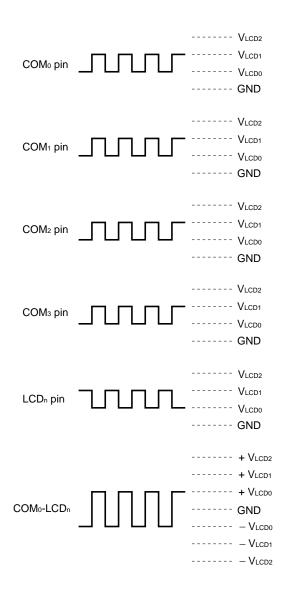
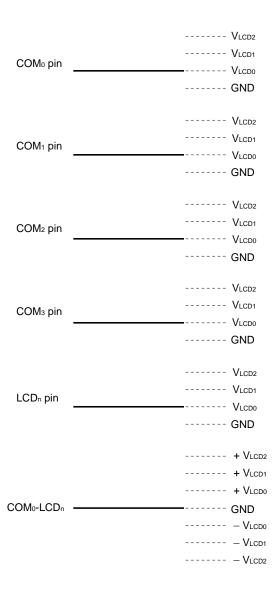


Fig. 11-10 Common and Segment Waveforms for LCDMD0 = 0 and LCDMD1 = 0 (Voltage Booster Circuit Stop)



11.6 VOLTAGE BOOSTER CIRCUIT FOR LCD DRIVER

The μ PD17207 has a voltage booster circuit for LCD driver which prevents the LCD from flickering when the supply voltage fluctuates.

Output signals VLCD2, VLCD1, and VLCD0 of the segment and common signals are respectively two times (VLCD1), three times (VLCD2), and equal to the output (reference voltage, VLCD0) of the reference voltage generator. The reference voltage VLCD0 can be adjusted by a resistor connected to the Reference Voltage Adjuster for LCD driver pin VLCDC.

Figure 11-11 shows an example of a circuit of adjusting the reference voltage for the LCD driver. Figure 11-12 shows its operating principle.

VLCD2
VLCD1
VLCD0

R1

C2

C3

C4

CAPH

CAPL

C1

Fig. 11-11 Reference Voltage Adjusting Circuit for LCD Driver (Example)

R1 + R2 =
$$2M\Omega$$

C1 = C2 = C3 = C4 = 0.47 μ F

Reference voltage V_{LCD0} can be adjusted by resistors R1 and R2. Where $V_{\text{LCDC}} = 0.6 \text{ V}$,

$$V_{LCD0} = \frac{R1 + R2}{R2} \times 0.6 \text{ (V)}$$

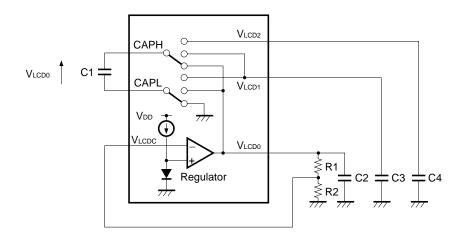
$$V_{LCD1} = 2 \times V_{LCD0} \text{ (V)}$$

$$V_{LCD2} = 3 \times V_{LCD0} \text{ (V)}$$

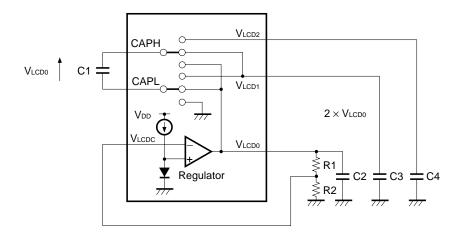
Caution When the power is switched on, the LCD may light until the supply voltage stabilizes because the voltages of the capacitors for the voltage regulator and driver are undefined. It is therefore recommended that the all-light mode be used immediately after the power is switched on.

Fig. 11-12 Operating Principle of LCD Driver Voltage Booster Circuit

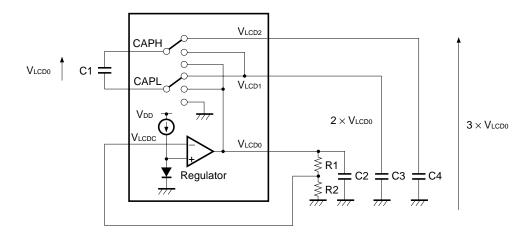
(1) Charge C1 with VLCD0 (VLCD0).



(2) Charge C3 with VLCD0 and voltage of C1 (VLCD0 + VLCD0 = 2 × VLCD0).



(3) Charge C4 with voltage of C3 and voltage of C1 ($2 \times V_{LCD0} + V_{LCD0} = 3 \times V_{LCD0}$).



(1) through (3) are repeated to boost the voltage. () indicates the logical value eventually reached. The voltage is not necessarily boosted to the level in () at a time.

12. INTERRUPT FUNCTIONS

When a peripheral hardware unit (INT pin, 8-bit timer, clock timer, or serial interface) makes an interrupt request, the interrupt function temporarily stops the execution of the current program and transfers program control to a predetermined address (termed a vector address).

12.1 INTERRUPT SOURCES

The μ PD17207 supports the four interrupt sources (see Table 12-1).

When accepting an interrupt, the μ PD17207 automatically transfers program control to a predetermined address (called a vector address).

Priority	Interrupt Source	Vector Address	
1	8-bit timer	(Internal)	0004H
2	Rising edge of INT pin input	(External)	0003H
3	Clock timer	(Internal)	0002H
4	Serial interface	(Internal)	0001H

Table 12-1 Vector Addresses

If two or more interrupt requests are issued at the same time, the interrupt requests are accepted according to the priorities assigned to them.

Accepting an interrupt is enabled or disabled by the EI or DI instruction. Basically, the interrupt is accepted when it is enabled by the EI instruction. While the DI instruction is executed or while an interrupt is accepted, the other interrupts are disabled.

To enable accepting another interrupt after one interrupt has been completed, the EI instruction must be executed before the RETI instruction.

The interrupt is accepted by the EI instruction after the instruction next to EI has been executed; therefore, no interrupt is accepted between the EI and RETI instructions.

12.2 HARDWARE OF INTERRUPT CONTROL CIRCUIT

This section describes the flags of the interrupt control circuit.

(1) Interrupt request flag and interrupt enable flag

The interrupt request flag (IRQxxx) is set to 1 when an interrupt request is generated, and is automatically cleared to 0 when the interrupt processing is executed.

An interrupt enable flag (IPxxx) is provided to each interrupt request flag. When the IPxxx flag is 1, the interrupt is enabled; when it is 0, the interrupt is disabled.

(2) EI/DI instruction

Whether an accepted interrupt is executed or not is specified by the EI or DI instruction.

When the EI instruction is executed, INTE (interrupt enable flag), which enables the interrupt, is set to 1. The INTE flag is not registered on the register file. Consequently, the status of this flag cannot be checked by an instruction.

The DI flag clears the INTE flag to 0 to disable all the interrupts.

The INTE flag is also cleared to 0 at reset, disabling all the interrupts.

Table 12-2 Interrupt Request Flags and Interrupt Enable Flags

Interrupt Request Flag	Signal Setting Interrupt Request Flag	Interrupt Enable Flag
IRQ	Set when rising edge of INT pin input signal is detected	IP
IRQTM	Set by coincidence signal of 8-bit timer	IPTM
IRQWTM	Set by interrupt request signal from watch timer. Interrupt request signal generation interval is selected by WTMMD flag (RF: 03H, bit 2)	IPWTM
IRQSIO	Set by signal indicating end of serial data transfer operation from serial interface	IPSIO

12.2.1 INT Flag

This flag reads the status of the INT pin. This flag is "1" when a high-level signal is on the INT pin or "0" when a low-level signal is there.

Fig. 12-1 INT flag

					•
RF: Address 0FH	Bit 3	Bit 2	Bit 1	Bit 0	
	0	0	0	I N T	
Read/write		F	₹		R: Read
Default at reset	0	0	0	_	-: Undefined
					INT

	Function
0	INT pin is low
1	INT pin is high

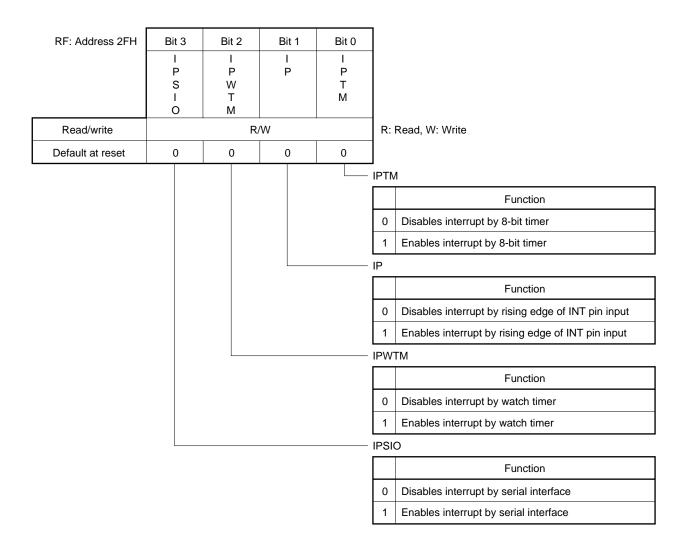


12.2.2 Interrupt Enable Flags

These flags enable the corresponding interrupts to be accepted.

- 1: The interrupt is accepted.
- 2: The interrupt is not accepted.

Fig. 12-2 Interrupt Enable Flags



12.2.3 Interrupt Request Flags

These flags indicates the occurrence or acceptance of the corresponding interrupt requests.

- 1: The interrupt request has been made.
- 0: The interrupt request has been accepted.

It is possible to set the status of each Interrupt Request flag by programming. When you write "1" in an Interrupt Request flag, the corresponding interrupt can be generated by software. When you write "0" in an Interrupt Request flag, the corresponding interrupt being held is released.

Fig. 12-3 Interrupt Request Flags (1/4)

RF: Address 3BH	Bit 3	Bit 2	Bit 1	Bit 0
	- R Q S - O	0	0	0
Read/write	R/W	R	R	R
Default at reset	0	0	0	0

R: Read, W: Write

IRQSIO

	Function
0	Serial interface interrupt request has not been made.
1	Serial interface interrupt request has been made.

Fig. 12-3 Interrupt Request Flags (2/4)

RF: Address 3CH	Bit 3	Bit 2	Bit 1	Bit 0
	0	-RQ⊗⊢M	0	0
Read/write	R	R/W	R	R
Default at reset	0	0	0	0

R: Read, W: Write

IRQWTM

	Function
0	Watch timer interrupt request has not been made.
1	Watch timer interrupt request has been made.

Fig. 12-3 Interrupt Request Flags (3/4)

RF: Address 3DH	Bit 3	Bit 2	Bit 1	Bit 0
	0	0	I R Q	0
Read/write	R	R	R/W	R
Default at reset	0	0	0	0

R: Read, W: Write

IRQ

	Function
0	Interrupt request has not been made at rising edge of INT pin input.
1	Interrupt request has been made at rising edge of INT pin input.

Fig. 12-3 Interrupt Request Flags (4/4)

RF: Address 3EH	Bit 3	Bit 2	Bit 1	Bit 0
	0	0	0	I R Q T M
Read/write	R	R	R	R/W
Default at reset	0	0	0	1 Note

R: Read, W: Write

- IRQTM

	Function
0	8-bit timer interrupt request has not been made.
1	8-bit timer interrupt request has been made.

Note 1H even after the STOP mode has been released.

12.3 INTERRUPT SEQUENCE

If the IRQxx flag is set to "1" while the IPxx is "1", processing of an interrupt starts at the end of the instruction cycle of the instruction being executed when the IRQxx flag was set. Processing of an instruction made in the execution of an MOVT instruction starts at the end of the second instruction cycle as the MOVT instruction runs in the second instruction cycle.

When the IPxx flag is "0", interrupt processing does not start until the IPxx flag is set even when the IRQxx flag is set.

When two or more interrupts are enabled, they are processed in the ascending order of priorities. (An interrupt must wait until processing of an interrupt of the higher priority ends.)

12.3.1 Operations When Interrupt Is Accepted

When an interrupt has been accepted, the CPU performs processing in the following sequence:

- (1) Decrements the value of the stack pointer (SP) by 1.
- (2) Saves the current value of the program counter to the address stack register (ASR) specified by the SP. If the branch (BR) or subroutine call (CALL) instruction is executed when the interrupt has been accepted, the address of the program memory (ROM) to which execution is to branch, or called is loaded to the PC.
- (3) Saves the value of each flag (BCD, CMP, CY, Z, IXE) of the bank register (BANK) and program status word (PSWORD) to the interrupt stack register (INTSK, three levels).
- (4) Transfers the vector address to the PC.

One instruction cycle is required to perform the above processing.

12.3.2 Returning from Interrupt Processing Routine

To return from an interrupt processing routine, use the RETI instruction.

Then the following processing is executed within an instruction cycle.

- (1) Restores the value of the interrupt stack register (INTSK) to each flag (BCD, CMP, CY, Z, IXE) of the program status word (PSWORD).
- (2) Restores the value of the address stack register (ASR) specified by the stack pointer (SP) to the program counter.
- (3) Increments the value of the stack pointer by 1.

To accept another interrupt after an interrupt has been processed, it is necessary to execute an EI instruction before the RETI instruction.

An interrupt will never be accepted between the EI and RETI instructions as an interrupt is accepted by the EI instruction only after the next instruction has been executed.

13. STANDBY FUNCTIONS

The μ PD17207 has two modes of standby functions: HALT mode and STOP mode. The standby functions reduce the power dissipation of the μ PD17207.

In HALT mode, the μ PD17207 stops the execution of the program with the main clock on. (The CPU stops to run.) This mode is kept until a HALT releasing condition is satisfied.

In STOP mode, the μ PD17207 stops the execution of the program with the main clock off. The μ PD17207 dissipates less circuit current in STOP mode than in HALT mode.

HALT mode is set by the execution of a HALT instruction and STOP mode is set by the execution of a STOP instruction.

13.1 HALT MODE

In HALT mode, the μ PD17207 stops the execution of the program with the main clock on for reduction of its power dissipation.

Execute a HALT instruction to set HALT mode.

The condition of releasing HALT mode is determined by the operand of the HALT instruction. See Table 13-1. After HALT mode is released, the μ PD17207 performs operations as shown in Table 13-2.

Caution Do not execute an instruction to clear the interrupt request flag (IRQxxx) whose interrupt enable flag (IPxxx) is set immediately before the HALT 8H or HALT 0AH instruction is executed. If the flag is cleared, the HALT mode may not be set.

Table 13-1 HALT Mode Releasing Conditions

Operand Value	HALT Mode Releasing Condition
0010B (02H)	When an 8-bit timer interrupt request (IRQTM) is made
1000B (08H)	 When an interrupt request (IRQTM, IRQWTM, IRQSIO, or IRQ) is made for an interrupt whose enable flag (IPTM, IPWTM, IPSIO, or IP) is on ("1") When any of pins P0A₀ to P0A₃ goes low
1010B (0AH)	 When an 8-bit timer interrupt request (IRQTM) is made When an interrupt request (IRQWTM, IRQSIO, or IRQ) is made for an interrupt whose enable flag (IPWTM, IPSIO, or IP) is on ("1")
Others	Inhibited



Table 13-2 Operations after HALT Mode Has Been Released

(a) HALT 02H

Standby Mode Released by:	Interrupt Enable Status	Interrupt Enable Flag	Operation after Release of Standby Mode
Satisfaction of Release	DI	Disable	Execution starts from instruction following
Condition by Interrupt		Enable	HALT
Request (IRQTM)	EI	Disable	
		Enable	Branches to vector address of interrupt

(b) HALT 08H

Standby Mode Released by:	Interrupt Enable Status	Interrupt Enable Flag	Operation after Release of Standby Mode
Low Level Input to Port 0A	Don't care	Don't care	Execution starts from instruction following HALT
Satisfaction of Release	DI	Disable	Standby mode is not released
Condition by Interrupt		Enable	Execution starts from instruction following
Request (IRQTM, IRQWTM,			HALT
IRQSIO, or IRQ)	EI	Disable	Standby mode is not released
		Enable	Branches to vector address of interrupt

(c) HALT 0AH

Standby Mode Released by:	Interrupt Enable Status	Interrupt Enable Flag	Operation after Release of Standby Mode
Satisfaction of Release	DI	Disable	Execution starts from instruction following
Condition by Interrupt		Enable	HALT
Request (IRQTM)	EI	Disable	
		Enable	Branches to vector address of interrupt
Satisfaction of Release	DI	Disable	Standby mode is not released
Condition by Interrupt		Enable	Execution starts from instruction
Request (IRQWTM, IRQSIO,			following HALT
or IRQ)	EI	Disable	Standby mode is not released
		Enable	Branches to vector address of interrupt



13.2 CONDITIONS OF EXECUTING AN HALT INSTRUCTION

The HALT instruction can be executed only under a specific condition for prevention of malfunction. See Table 13-3.

The HALT instruction which does not satisfy the conditions listed in Table 13-3 is treated as an NOP instruction.

Table 13-3 Conditions of Executing the HALT Instruction

Operand Value	Execution Condition
0010B (02H)	The 8-bit timer interrupt request (IRQTM) should be reset.
1000B (08H)	 The interrupt request flag (IRQTM, IRQWTM, IRQSIO, or IRQ) should be reset for an interrupt whose enable flag (IPTM, IPWTM, IPSIO, or IP) is on ("1") All of pins P0Ao to P0Ao should be high input or output. All of pins P0Bo to P0Bo should be in output mode and output latch should be "0".
1010B (0AH)	 The 8-bit timer interrupt request (IRQTM) should be reset. The interrupt request flag (IRQWTM, IRQSIO, or IRQ) should be reset for an interrupt whose enable flag (IPWTM, IPSIO, or IP) is on ("1")
Others	Reserved

13.3 STOP MODE

In STOP mode, the μ PD17207 stops the execution of the program with the main clock temporarily off for great reduction of its power dissipation. Execute a STOP instruction to set STOP mode.

The STOP instruction is not valid for a system using a subclock only. When the system uses a subclock as the system clock (that is, when SYSCK = 0), the STOP instruction is treated as an NOP instruction.

The condition of releasing STOP mode is determined by the operand of the STOP instruction. See Table 13-4. After STOP mode is released, the μ PD17207 performs operations as follows:

- 1 Clearing IRQTM
- (2) Starting watch timer and watchdog timer (not reset)
- 3 Resetting and starting 8-bit timer
- 4 The instruction following STOP 8H or the interrupt vector address is executed when the value of the 8-bit counter coincides with the value of the modulo register (setting of IRQTM).

Caution When the subclock is used, the watch timer and watchdog timer do not stop even in the STOP mode.

The time interval between release of STOP mode and start of the execution of the next instruction is set by the contents of the modulo register of the 8-bit timer. This time interval is expressed as follows:

(TMM +1) x 1024/fx [sec]

where,

TMM: Content of the modulo register fx: Frequency of the main clock.

Example: In a system using the main clock of 4 MHz, the time interval between release of STOP mode and start of the execution of the next instruction is:

(TMM + 1) x 256 [microseconds]

Caution Do not set an instruction that would clear the interrupt request flag (IRQxxx) whose interrupt enable flag (IPxxx) is set immediately before the STOP 8H instruction, if you set such an instruction, the STOP mode may not be set.

Table 13-4 STOP Mode Releasing Conditions

Operand Value	STOP Mode Releasing Condition
1000B (08H)	 When an interrupt request (IRQWTM, IRQSIO, or IRQ) is made for an interrupt whose enable flag (IPWTM, IPSIO, or IP) is on ("1") When any of pins P0A₀ to P0A₃ goes low
Others	Inhibited

13.4 CONDITIONS OF EXECUTING AN HALT INSTRUCTION

The STOP instruction can be executed only under a specific condition for prevention of malfunction. See Table 13-5.

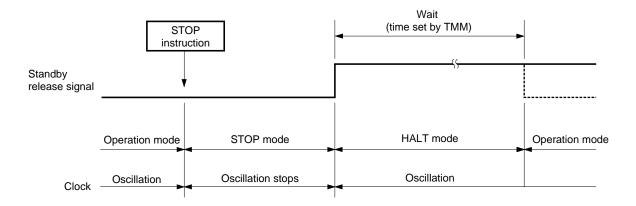
The STOP instruction which does not satisfy the conditions listed in Table 13-5 is treated as an NOP instruction.

Table 13-5 Conditions of Executing the STOP Instruction

Operand Value	Execution Condition
1000B (08H)	 The interrupt request flag should be reset for an interrupt whose enable flag (IPWTM, IPSIO, or IP) is on ("1") All of pins P0Ao to P0A3 should be high input or output. All of pins P0Bo to P0B3 should be in output mode and output latch should be "0".
Others	Inhibited

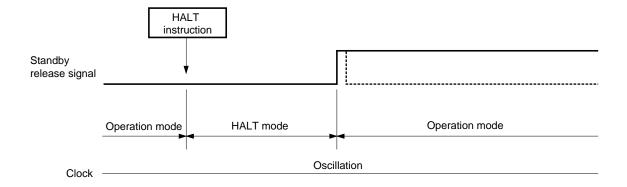
Fig. 13-1 Releasing Standby Mode

(a) Releasing STOP mode by interrupt



Remark The dotted line indicates when the interrupt that has released the standby mode is accepted

(b) Releasing HALT mode by interrupt



Remark The dotted line indicates when the interrupt that has released the standby mode is accepted

14. RESET

14.1 RESET BY RESET SIGNAL INPUT

When a low-level signal is input to the \overline{RESET} pin for 50 μs or more, the system is reset.

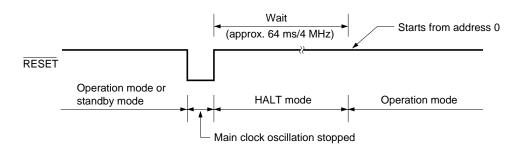
The system must be reset at least once when the power is turned on, as the operation of the internal circuit is undefined.

When reset has been effected, the following circuits are initialized:

- 1) The program counter is reset to 0.
- (2) The flags of the register file are initialized (for the initial values, refer to Fig. 15-1 Register File List).
- (3) Initial value 0320H is written to the data buffer.
- (4) The peripheral hardware is initialized.
- (5) Oscillation of the main clock is stopped.

When the RESET pin is made high, oscillation of the main clock is started, and about 64 ms after that (where the main clock frequency is 4 MHz), execution of the program is started from address 0.

Fig. 14-1 Reset Operation by RESET Input



14.2 RESET BY WATCHDOG TIMER (RESET AND WOOUT PINS CONNECTED)

When the watchdog timer is activated while the program is being executed, a low level is output to the WDOUT pin, and the program counter is reset to 0.

Therefore, when the watchdog timer is not reset for a fixed period of time, the program can be restarted from address 0.

When developing a program, reset the watchdog timer (set the WDTRES flag) at intervals of 340 ms or less (where $f_x = 4 \text{ MHz}$).

14.3 RESET BY STACK POINTER (RESET AND WDOUT PINS CONNECTED)

When the value of the stack pointer reaches 6H or 7H while the program is being executed, a low level is output to the $\overline{\text{WDOUT}}$ pin, and the program counter is reset to 0.

When the level of nesting of interrupt or subroutine call exceeds 5 (stack overflow), or when the return instruction is executed despite the stack level being 0 because the call instruction and return (RET) instruction have not been correctly used in pairs (stack underflow), the program can be restarted from address 0.



Table 14-1 Hardware Status after Reset

	Hardware	RESET Input in Standby Mode	RESET Input during Operation	
Program Counter (PC)		0000H	0000H	
Port	I/O	Input	Input	
	Output Latch	0	0	
Data Memory (RAM)	General-Purpose Data Memory (except DBF and port register)	Holds previous status	Undefined	
	DBF	0320H	0320H	
	System Register (SYSREG)	0	0	
	WR	Holds previous status	Undefined	
Control Register		Refer to Fig. 15-1 Register File List.		
8-bit Timer	Counter (TMC)	00H	00H	
	Modulo Register (TMM)	FFH	FFH	
Remote Controller Carrier Generator Circuit	NRZ High-Level Period Setting Modulo Register (NRZHTMM)	Holds previous status	Undefined	
	NRZ Low-Level Period Setting Modulo Register (NRZLTMM)			
Counter of Watch Timer/Wa	tchdog Timer	00H	00H	
Shift Register of Serial Inter	face (SIOSFR)	Holds previous status	Undefined	
Internal Reference Voltage	Setting Register of A/D Converter (ADCR)	Holds previous status	Undefined	

15. ASSEMBLER RESERVED WORDS

15.1 MASK OPTION DIRECTIVES

In μ PD17207 programming, it is required to specify mask options in assembler source programs by mask option directives.

The following mask options items must be specified:

- Pull-up resistor for the RESET pin
- · Connection between the main clock and the subclock (for selection of system clock)

15.1.1 OPTION and ENDOP Directives

A mask option is defined in a block between the OPTION and ENDOP directives. This block is formatted as shown below.







15.1.2 Mask Option Definition Pseudo Directives

Table 15-1 shows directives available in the mask option definition block.

Table 15-1 Mask Option Definition Directives

Item	Directives	Number of Operands	1st Operand	2nd Operands
RESET pin pull-up resistor	OPTRES	1	RESET mask option RESPLUP (Built-in pull-up resistor) OPEN (No pull-up resistor)	
			Main clock	Subclock
System clock	OPTCK	2	USEX (Uses the main clock as the system clock.) NOX (Does not use the main clock.)	USEXT Uses the subclock as the system clock.) NOXT (Does not use the subclock.)

Remark When both the main clock and the subclock are specified as the system clock, the main clock is initially selected when the system is reset. After that, the subclock can be selected by an instruction in the program.

Shown below is a coding example of mask options.

Symbol	Mnemonic	Operand	Comment
[Label:]	OPTION		[;Comment]
	OPTRES	RESPLUP	; Pulls up the \overline{RESET} pin.
	OPTCK	USEX, USEXT	; Uses the main clock or subclock.
	ENDOP		

15.2 RESERVED SYMBOLS

Table 15-2 lists the symbols defined by the device file of the μ PD17207.

The defined symbols include the following register file names, port names, and peripheral hardware names.

15.2.1 Register File

The symbol names assigned to the registers in the register file are defined. These registers are accessed via WR (window register) by the PEEK and POKE instructions. Fig. 15-1 lists the registers in the register file.

15.2.2 Registers on Data Memory and Ports

The names of the registers assigned to data memory addresses 00H-7FH, ports assigned to address 70H and those that follow, and system registers are defined. Fig. 15-2 shows the configuration of the data memory.

15.2.3 Peripheral Hardware

The names of the peripheral hardware that is accessed by the GET and PUT instructions are defined. Table 15-3 lists the peripheral hardware.



Table 15-2 List of Reserved Symbols (1/4)

Symbol Name	Attribute	Value	R/W	Description
DBF3	MEM	0.0CH	R/W	Bit 15 to bit 12 of data buffer
DBF2	MEM	0.0DH	R/W	Bit 11 to bit 8 of data buffer
DBF1	MEM	0.0EH	R/W	Bit 7 to bit 4 of data buffer
DBF0	MEM	0.0FH	R/W	Bit 3 to bit 0 of data buffer
AR3	MEM	0.74H	R	Bit 15 to bit 12 of address register
AR2	MEM	0.75H	R/W	Bit 11 to bit 8 of address register
AR1	MEM	0.76H	R/W	Bit 7 to bit 4 of address register
AR0	MEM	0.77H	R/W	Bit 3 to bit 0 of address register
WR	MEM	0.78H	R/W	Window register
BANK	MEM	0.79H	R/W	Bank register
IXH	MEM	0.7AH	R/W	Bit 11 to bit 8 of index register
MPH	MEM	0.7AH	R/W	Bit 7 to bit 4 of memory pointer
MPE	FLG	0.7AH.3	R/W	Memory pointer enable flag
IXM	MEM	0.7BH	R/W	Bit 7 to bit 4 of index register
MPL	MEM	0.7BH	R/W	Bit 3 to bit 0 of memory pointer
IXL	MEM	0.7CH	R/W	Bit 3 to bit 0 of index register
RPH	MEM	0.7DH	R/W	Bit 7 to bit 4 of register pointer
RPL	MEM	0.7EH	R/W	Bit 3 to bit 0 of register pointer
PSW	MEM	0.7FH	R/W	Program status word
BCD	FLG	0.7EH.0	R/W	BCD operation flag
CMP	FLG	0.7FH.3	R/W	Compare flag
CY	FLG	0.7FH.2	R/W	Carry flag
Z	FLG	0.7FH.1	R/W	Zero flag
IXE	FLG	0.7FH.0	R/W	Index register enable flag
LCDD0	MEM	0.40H	R/W	LCD segment 0
LCDD1	MEM	0.41H	R/W	LCD segment 1
LCDD2	MEM	0.42H	R/W	LCD segment 2
LCDD3	MEM	0.43H	R/W	LCD segment 3
LCDD4	MEM	0.44H	R/W	LCD segment 4
LCDD5	MEM	0.45H	R/W	LCD segment 5
LCDD6	MEM	0.46H	R/W	LCD segment 6
LCDD7	MEM	0.47H	R/W	LCD segment 7
LCDD8	MEM	0.48H	R/W	LCD segment 8
LCDD9	MEM	0.49H	R/W	LCD segment 9
LCDD10	MEM	0.4AH	R/W	LCD segment 10
LCDD11	MEM	0.4BH	R/W	LCD segment 11
LCDD12	MEM	0.4CH	R/W	LCD segment 12
LCDD13	MEM	0.4DH	R/W	LCD segment 13
LCDD14	MEM	0.4EH	R/W	LCD segment 14
LCDD15	MEM	0.4FH	R/W	LCD segment 15



Table 15-2 List of Reserved Symbols (2/4)

Symbol Name	Attribute	Value	R/W	Description
LCDD16	MEM	0.50H	R/W	LCD segment 16
LCDD17	MEM	0.51H	R/W	LCD segment 17
LCDD18	MEM	0.52H	R/W	LCD segment 18
LCDD19	MEM	0.53H	R/W	LCD segment 19
LCDD20	MEM	0.54H	R/W	LCD segment 20
LCDD21	MEM	0.55H	R/W	LCD segment 21
LCDD22	MEM	0.56H	R/W	LCD segment 22
LCDD23	MEM	0.57H	R/W	LCD segment 23
LCDD24	MEM	0.58H	R/W	LCD segment 24
LCDD25	MEM	0.59H	R/W	LCD segment 25
LCDD26	MEM	0.5AH	R/W	LCD segment 26
LCDD27	MEM	0.5BH	R/W	LCD segment 27
LCDD28	MEM	0.5CH	R/W	LCD segment 28
LCDD29	MEM	0.5DH	R/W	LCD segment 29
LCDD30	MEM	0.5EH	R/W	LCD segment 30
LCDD31	MEM	0.5FH	R/W	LCD segment 31
LCDD32	MEM	0.60H	R/W	LCD segment 32
LCDD33	MEM	0.61H	R/W	LCD segment 33
LCDD34	MEM	0.62H	R/W	LCD segment 34
LCDD35	MEM	0.63H	R/W	LCD segment 35
P0A0	FLG	0.70H.0	R/W	Bit 0 of port 0A
P0A1	FLG	0.70H.1	R/W	Bit 1 of port 0A
P0A2	FLG	0.70H.2	R/W	Bit 2 of port 0A
P0A3	FLG	0.70H.3	R/W	Bit 3 of port 0A
P0B0	FLG	0.71H.0	R/W	Bit 0 of port 0B
P0B1	FLG	0.71H.1	R/W	Bit 1 of port 0B
P0B2	FLG	0.71H.2	R/W	Bit 2 of port 0B
P0B3	FLG	0.71H.3	R/W	Bit 3 of port 0B
P0C0	FLG	0.72H.0	R/W	Bit 0 of port 0C
P0C1	FLG	0.72H.1	R/W	Bit 1 of port 0C
P0C2	FLG	0.72H.2	R/W	Bit 2 of port 0C
P0C3	FLG	0.72H.3	R/W	Bit 3 of port 0C
P0D0	FLG	0.73H.0	R/W	Bit 0 of port 0D
P0D1	FLG	0.73H.1	R/W	Bit 1 of port 0D
P0D2	FLG	0.73H.2	R/W	Bit 2 of port 0D
P0D3	FLG	0.73H.3	R/W	Bit 3 of port 0D
P1A0	FLG	1.70H.0	R/W	Bit 0 of port 1A
P1A1	FLG	1.70H.1	R/W	Bit 1 of port 1A
P1A2	FLG	1.70H.2	R/W	Bit 2 of port 1A
P1A3	FLG	1.70H.3	R/W	Bit 3 of port 1A

Table 15-2 List of Reserved Symbols (3/4)

Symbol Name	Attribute	Value	R/W	Description
SP	MEM	0.81H	R/W	Stack pointer
SYSCK	FLG	0.82H.1	R/W	Selection of system clock
XEN	FLG	0.82H.0	R/W	Main clock enable
WDTRES	FLG	0.83H.3	R/W	Watchdog timer reset
WTMMD	FLG	0.83H.2	R/W	Selection of watch timer mode
WTMRES	FLG	0.83H.1	R/W	Reset of watch timer mode
INT	FLG	0.8FH.0	R	INT pin status
NRZBF	FLG	0.91H.0	R/W	NRZ buffer data
NRZ	FLG	0.92H.0	R/W	NRZ data
ADCCMP	FLG	0.0A0H.0	R/W	Comparator result
VREFEN	FLG	0.0A1H.3	R/W	A/D converter enable flag
ADCEN	FLG	0.0A1H.2	R/W	A/D converter enable flag
ADCCH1	FLG	0.0A1H.1	R/W	A/D converter channel selection flag
ADCCH0	FLG	0.0A1H.0	R/W	A/D converter channel selection flag
SIOTS	FLG	0.0A2H.3	R/W	Serial interface start flag
SIOHIZ	FLG	0.0A2H.2	R/W	SO pin status
SIOCK1	FLG	0.0A2H.1	R/W	Serial clock selection flag for serial interface
SIOCK0	FLG	0.0A2H.0	R/W	Serial clock selection flag for serial interface
NRZEN	FLG	0.0A3H.2	R/W	NRZ enable flag
TMOE	FLG	0.0A3H.1	R/W	Timer output enable flag
SIOEN	FLG	0.0A3H.0	R/W	SIO enable flag
P0DBIO3	FLG	0.0A7H.3	R/W	I/O setting flag (bit 3 of port P0D)
P0DBIO2	FLG	0.0A7H.2	R/W	I/O setting flag (bit 2 of port P0D)
P0DBIO1	FLG	0.0A7H.1	R/W	I/O setting flag (bit 1 of port P0D)
P0DBIO0	FLG	0.0A7H.0	R/W	I/O setting flag (bit 0 of port P0D)
IPSIO	FLG	0.0AFH.3	R/W	INTSIO interrupt enable flag
IPWTM	FLG	0.0AFH.2	R/W	Watch timer interrupt enable flag
IP	FLG	0.0AFH.1	R/W	Interrupt enable flag
IPTM	FLG	0.0AFH.0	R/W	8-Bit timer interrupt enable flag
LCDEN	FLG	0.0B1H.3	R/W	LCD display enable flag
LCDCK2	FLG	0.0B1H.2	R/W	LCD display clock selection flag
LCDCK1	FLG	0.0B1H.1	R/W	LCD display clock selection flag
LCDCK0	FLG	0.0B1H.0	R/W	LCD display clock selection flag
LCDMD3	FLG	0.0B2H.3	R/W	LCD display mode register bit 3
LCDMD2	FLG	0.0B2H.2	R/W	LCD display mode register bit 2
LCDMD1	FLG	0.0B2H.1	R/W	LCD display mode register bit 1
LCDMD0	FLG	0.0B2H.0	R/W	LCD display mode register bit 0
TMEN	FLG	0.0B3H.3	R/W	Timer enable flag
TMRES	FLG	0.0B3H.2	R/W	Timer reset flag
TMCK1	FLG	0.0B3H.1	R/W	Selection of timer clock source



Table 15-2 List of Reserved Symbols (4/4)

Symbol Name	Attribute	Value	R/W	Description
TMCK0	FLG	0.0B3H.0	R/W	Selection of timer clock source
P1AGIO	FLG	0.0B7H.3	R/W	I/O setting flag for port 1A
P0CGIO	FLG	0.0B7H.2	R/W	I/O setting flag for port 0C
P0BGIO	FLG	0.0B7H.1	R/W	I/O setting flag for port 0B
P0AGIO	FLG	0.0B7H.0	R/W	I/O setting flag for port 0A
IRQSIO	FLG	0.0BBH.3	R/W	SIO interrupt request flag
IRQWTM	FLG	0.0BCH.2	R/W	Watch timer interrupt request flag
IRQ	FLG	0.0BDH.1	R/W	INT interrupt request flag
IRQTM	FLG	0.0BEH.0	R/W	8-bit timer interrupt request flag
SIOSFR	DAT	01H	R/W	Serial interface shift register
TMM	DAT	02H	W	Modulo register for 8-bit timer
TMC	DAT	02H	R	Counter register for 8-bit timer
NRZHTMM	DAT	03H	R/W	Modulo register for NRZ low-level period
NRZLTMM	DAT	04H	R/W	Modulo register for NRZ high-level period
ADCR	DAT	05H	R/W	A/D converter internal reference voltage setting register
AR	DAT	40H	R/W	Peripheral address of address register for GET/PUT/PUSH/CALL/BR/MOVT/INC instruction



[MEMO]

Cdolumn 0 2 3 4 5 6 7 1 Address Note Note Note Note Note Note Note Note Row Address Bit 3 0 0 0 0 WDTRES 0 Bit 2 0 0 0 WTMMD 0 (8)Bit 1 0 SYSCK WTMRES 0 SP Bit 0 XEN 0 0 0 Bit 3 0 0 0 0 Bit 2 0 0 (9)Bit 1 0 0 0 0 Bit 0 NRZBF 0 NRZ 0 0 Bit 3 0 0 VREFEN SIOTS 0 0 P0DBIO3 0 Bit 2 0 ADCEN SIOHIZ 0 NRZEN 0 P0DBIO2 0 (A) 0 0 ADCCH1 0 SIOCK1 P0DBIO1 0 Bit 1 0 0 TMOE Bit 0 ADCCMP 0 ADCCH0 SIOCK0 0 SIOEN 0 P0DBIO0 0 **LCDEN** 0 LCDMD3 0 P1AGIO Bit 3 **TMEN** Bit 2 LCDCK2 10 LCDMD2 **TMRES** 0 P0CGIO 3 (B) LCDCK1 0 LCDMD1 P0BGIO Bit 1 0 TMCK1 0 0 LCDCK0 0 LCDMD0 Bit 0 TMCK0 0 P0AGIO

Fig. 15-1 Register File (1/2)

Note Status when the system is reset.

*: When the mask option selects the main clock (USEX): 1
When the mask option does not select the main clock (NOX): 0

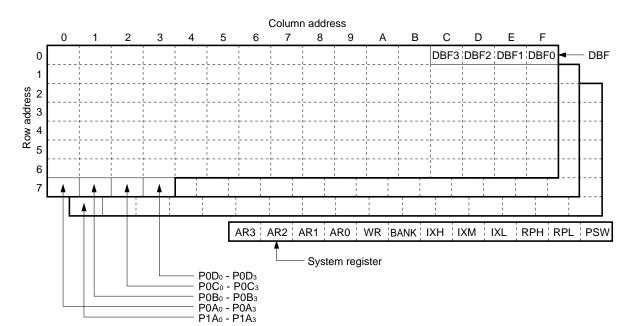


Fig. 15-2 Data Memory Configuration

Fig. 15-1 Register File (2/2)

	Cdolumn Address	8	9	Α	В		С		D		E		F	
Row Add	r Iress	Note	Note	Note		Note		Note	- - 	Note		Note		Note
	Bit 3	1				1		1 1 1	1				0	0
0	Bit 2	 		 - - -					 				0	0
(8)	Bit 1	1										-	0	0
	Bit 0		-										INT	Р
	Bit 3													
1	Bit 2	- - -		- - - -					 					
(9)	Bit 1	-							 					
	Bit 0													
	Bit 3					1			 				IPSIO	0
2	Bit 2	- - - -		- - -					 				IPWTM	0
(A)	Bit 1	-											ΙP	0
	Bit 0												IPTM	0
	Bit 3			1	IRQSIO	0	0	0	0	0	0	0		
3	Bit 2	 - -		 - - -	0	0	IRQWTM	0	0	0	0	0		
(B)	Bit 1	 - - -			0	0	0	0	IRQ	0	0	0		-
	Bit 0				0	0	0	0	0	0	IRQTM	0		

Note Status when the system is reset.

P: When the INT pin goes high: 1
When the INT pin goes low: 0

Remark () indicates an address to be used when the assembler is used.

All the flags of the control registers are registered to the device file as assembler reserved words. It is convenient to use these reserved words when you develop a program.

Table 15-3 Peripheral Hardware

Name	Address	Valid Bit	Remarks
SIOSFR	01H	8	Shift register of serial interface
TMC	02H	8	Count register of 8-bit timer
TMM	02H	8	Modulo register of 8-bit timer
NRZLTMM	03H	8	Low-level period setting modulo register for remote controller carrier generator
NRZHTMM	04H	8	High-level period setting modulo register for remote controller carrier generator
ADCR	05H	8	Compare voltage setting register of A/D converter
AR	40H	16	Address register

4



16. INSTRUCTION SET

16.1 OUTLINE OF INSTRUCTION SETS

	b ₁₅				
b14-b11			0		1
BIN	HEX				
0000	0	ADD	r, m	ADD	m, #n4
0001	1	SUB	r, m	SUB	m, #n4
0010	2	ADDC	r, m	ADDC	m, #n4
0011	3	SUBC	r, m	SUBC	m, #n4
0100	4	AND	r, m	AND	m, #n4
0101	5	XOR	r, m	XOR	m, #n4
0110	6	OR	r, m	OR	m, #n4
		INC	AR		
		INC	IX		
		MOVT	DBF, @AR		
		BR	@AR		
		CALL	@AR		
		RET			
		RETSK			
		EI			
		DI			
0111	7	RETI			
		PUSH	AR		
		POP	AR		
		GET	DBF, p		
		PUT	p. DBF		
		PEEK	WR, rf		
		POKE	rf, WR		
		RORC	r		
		STOP	S		
		HALT	h		
		NOP			
1000	8	LD	r, m	ST	m, r
1001	9	SKE	m, #n4	SKGE	m, #n4
1010	Α	MOV	@r, m	MOV	m, @r
1011	В	SKNE	m, #n4	SKLT	m, #n4
1100	С	BR	addr (Page 0)	CALL	addr (Page 0)
1101	D	BR	addr (Page 1)	MOV	m, #n4
1110	Е			SKT	m, #n
1111	F			SKF	m, #n

16.2 LEGEND

AR : Address register

ASR : Address stack register specified by stack pointer

addr : Program memory address (lower 11 bits)

BANK : Bank register
CMP : Compare flag
CY : Carry flag
DBF : Data buffer

h : Halt releasing condition INTEF : Interrupt enable flag

INTR : Register automatically saved to stack in case of interrupt

INTSK : Interrupt stack register

IX : Index register

MP : Data memory row address pointer

MPE : Memory pointer enable flag

m : Data memory address specified by mR, mc

mR : Data memory row address (high)mc : Data memory column address (low)

n : Bit position (4 bits) n4 : Immediate data (4 bits)

PAGE: Page (Bit 11 of program counter)

PC : Program counter p : Peripheral address

Peripheral address (higher 3 bits)
 Peripheral address (lower 4 bits)
 General register column address

rf : Register file address

rfc : Register file address (higher 3 bits)
rfc : Register file address (lower 4 bits)

SP : Stack pointer

s : Stop releasing condition

WR : Window register

 (\times) : Contents addressed by \times

*



16.3 LIST OF INSTRUCTION SETS

Group	Mnemonic	Operand	Operation		Instructi	on Code	
Oroup	Willomonio	Operand	operation.	OP code		Operand	
	ADD	r, m	$(r) \leftarrow (r) + (m)$	00000	MR	m c	r
	ADD	m, #n4	(m) ← (m) + n4	10000	MR	mc	n4
Addition	ADDC	r, m	$(r) \leftarrow (r) + (m) + CY$	00010	MR	mc	r
Addition	ADDC	m, #n4	(m) ← (m) + n4 + CY	10010	MR	mc	n4
	INC	AR	AR ← AR +1	00111	000	1001	0000
	INC	IX	IX ← IX +1	00111	000	1000	0000
	SUB	r, m	$(r) \leftarrow (r) - (m)$	00001	MR	mc	r
Subtraction	306	m, #n4	$(m) \leftarrow (m) - n4$	10001	MR	m c	n4
Subtraction	SUBC	r, m	$(r) \leftarrow (r) - (m) - CY$	00011	MR	m c	r
	SUBC	m, #n4	$(m) \leftarrow (m) - n4 - CY$	10011	MR	m c	n4
	OB	r, m	$(r) \leftarrow (r) \lor (m)$	00110	MR	m c	r
	OR	m, #n4	(m) ← (m) ∨ n4	10110	MR	m c	n4
Logical	AND	r, m	$(r) \leftarrow (r) \land (m)$	00100	MR	m c	r
Logical	AND	m, #n4	(m) ← (m) ∧ n4	10100	MR	m c	n4
	VOD	r, m	$(r) \leftarrow (r) \ \forall \ (m)$	00101	MR	m c	r
	XOR	m, #n4	(m) ← (m) ∀ n4	10101	MR	m c	n4
le des	SKT	m, #n	$CMP \leftarrow 0$, if (m) \wedge n = n, then skip	11110	MR	mc	n
Judge	SKF	m, #n	$CMP \leftarrow 0$, if (m) \land n = 0, then skip	11111	MR	m c	n
	SKE	m, #n4	(m)-n4, skip if zero	01001	MR	m c	n4
	SKNE	m, #n4	(m)-n4, skip if not zero	01011	MR	mс	n4
Compare	SKGE	m, #n4	(m)-n4, skip if not borrow	11001	MR	mc	n4
	SKLT	m, #n4	(m)-n4, skip if borrow	11011	MR	mc	n4
Rotate	RORC	r		00111	000	0111	r
	LD	r, m	(r) ← (m)	01000	MR	m c	r
	ST	m, r	(m) ← (r)	11000	MR	m c	r
		@r, m	if MPE = 1 : (MP, (r)) \leftarrow (m) if MPE = 0 : (BANK, mR, (r)) \leftarrow (m)	01010	MR	mc	r
Transfer	MOV	m, @r	if MPE = 1 : (m) \leftarrow (MP, (r)) if MPE = 0 : (m) \leftarrow (BANK, m _R , (r))	11010	m R	m c	r
		m, #n4	(m) ← n4	11101	mR	m c	n4
	MOVT ^{Note}	DBF, @AR	$SP \leftarrow SP - 1$, $ASR \leftarrow PC$, $PC \leftarrow AR$ $DBF \leftarrow (PC)$, $PC \leftarrow ASR$, $SP \leftarrow SP + 1$	00111	000	0001	0000

Note Two instruction cycles are necessary only for executing the MOVT instruction.

Group	Mnemonic	Operand	Operation		Instructi	on Code		
Group	winemonic	Operand	Operation	OP code	Operand			
	PUSH	AR	$SP \leftarrow SP - 1$, $ASR \leftarrow AR$	00111	000	1101	0000	
	POP	AR	$AR \leftarrow ASR, SP \leftarrow SP +1$	00111	000	1100	0000	
Transfer	PEEK	WR, rf	$WR \leftarrow (rf)$	00111	rfR	0011	rfc	
	POKE	rf, WR	$(rf) \leftarrow WR$	00111	rfR	0010	rfc	
	GET	DBF, p	$(DBF) \leftarrow (p)$	00111	рн	1011	р∟	
	PUT	p, DBF	(p) ← (DBF)	00111	рн	1010	р∟	
	BR	addr	$PC_{10-0} \leftarrow addr, PAGE \leftarrow 0$	01100		addr		
Branch			PC ₁₀₋₀ ← addr, PAGE ← 1	01101				
			@AR	PC ← AR	00111	000	0100	0000
	CALL	addr	$SP \leftarrow SP - 1$, $ASR \leftarrow PC$ $PC_{10-0} \leftarrow addr$, $PAGE \leftarrow 0$	11100		addr	addr	
Subroutine	CALL	@AR	$SP \leftarrow SP - 1$, $ASR \leftarrow PC$ $PC \leftarrow AR$	00111	000	0101	0000	
	RET		$PC \leftarrow ASR, SP \leftarrow SP +1$	00111	000	1110	0000	
	RETSK		$PC \leftarrow ASR, SP \leftarrow SP +1$ and skip	00111	001	1110	0000	
	RETI		$PC \leftarrow ASR, INTR \leftarrow INTSK, SP \leftarrow SP + \! 1$	00111	100	1110	0000	
Interrupt	EI		INTEF ← 1	00111	000	1111	0000	
плонирі	DI		INTEF ← 0	00111	001	1111	0000	
	STOP	S	STOP	00111	010	1111	S	
Other	HALT	h	HALT	00111	011	1111	h	
	NOP	_	No operation	00111	100	1111	0000	



★ 16.4 ASSEMBLER (AS17K) EMBEDDED MACROINSTRUCTIONS

Legend

flag n: FLG symbol
n: Bit number
< >: Can be omitted

	Mnemonic	Operand	Operation	n
Embedded	SKTn	flag 1, flag n	if (flag 1) ~ (flag n) = all "1", then skip	1 ≤ n ≤ 4
macro	SKFn	flag 1, flag n	if (flag 1) ~ (flag n) = all "0", then skip	1 ≤ n ≤ 4
	SETn	flag 1, flag n	(flag 1) ~ (flag n) ← 1	1 ≤ n ≤ 4
	CLRn	flag 1, flag n	(flag 1) ~ (flag n) \leftarrow 0	1 ≤ n ≤ 4
	NOTn	flag 1, flag n	if (flag n) = "0", then (flag n) \leftarrow 1 if (flag n) = "1", then (flag n) \leftarrow 0	1 ≤ n ≤ 4
	INITFLG	<not> flag 1, <<not> flag n></not></not>	if description = NOT flag n, then (flag n) \leftarrow 0 if description = flag n, then (flag n) \leftarrow 1	1 ≤ n ≤ 4
	BANKn		(BANK) ← n	0 ≤ n ≤ 2



17. ELECTRICAL SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Parameter	Symbol	Test Condi	tion	Rating	Unit
Supply voltage	V _{DD}			-0.3 to+7.0	V
Analog supply voltage	VADC			-0.3 to V _{DD} +0.3	V
Input voltage	Vı			-0.3 to V _{DD} +0.3	V
Output voltage	Vo			-0.3 to V _{DD} +0.3	V
		REM pin	Peak value	-30	mA
		IXEM PIII	Effective value	-20	mA
High-level output current	Іон	One pin (except REM)	Peak value	-7.5	mA
		One pin (except (CEN))	Effective value	-5	mA
		All pins (except REM)	Peak value	-22.5	mA
		All pills (except IXLIVI)	Effective value	-15	mA
		One pin	Peak value	7.5	mA
Low-level output current	lou	One pin	Effective value	5	mA
Low-level output current	IOL	All pins (except REM)	Peak value	22.5	mA
		All pills (except KLIVI)	Effective value	15	mA
Operating ambient temperature	TA			-20 to +75	°C
Storage temperature	T _{stg}			-40 to +125	°C

Note Effective value = Peak value x $\sqrt{\text{Duty}}$

Caution Even if one of the parameters exceeds its absolute maximum rating even momentarily, the quality of the product may be degraded. The absolute maximum rating therefore specifies the upper or lower limit of the value at which the product can be used without physical damages. Be sure not to exceed or fall below this value when using the product.

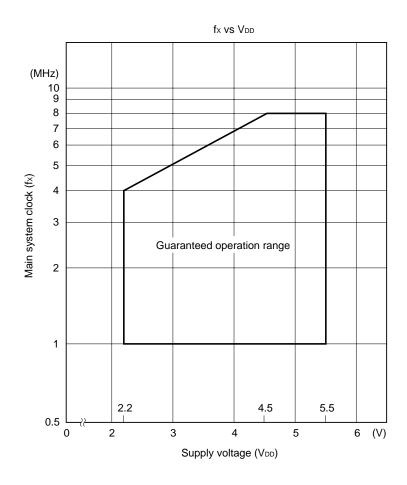
CAPACITANCE (TA = 25° C, VDD = 0 V)

Parameter	Symbol	Test Condition	MIN.	TYP.	MAX.	Unit
Input capacitance	Cin	INT, SI, and RESET pins			10	pF



RECOMMENDED OPERATING RANGES ($T_A = -20 \text{ to } +75^{\circ}\text{C}$)

Parameter	Symbol	Test Condition	MIN.	TYP.	MAX.	Unit
Supply voltage	V _{DD1}	System clock fx = 4 MHz	2.2	3.0	5.5	V
	V _{DD2}	System clock fx = 8 MHz	4.5	5.0	5.5	V
	V _{DD3}	System clock fxt = 32.768 kHz	2.0	3.0	5.5	V
Main clock oscillation frequency	fx		1.0	4	8.0	MHz
Subclock oscillation frequency	fхт			32.768		kHz



10

30

ms

ms

oscillator

Resonator Constants	Recommended	Item	Conditions	MIN.	TYP.	MAX.	Unit
Ceramic ^{Note 3} oscillator	X _{IN} Xout	Oscillation frequency (fX) ^{Note 1}		1.0	4	8.0	MHz
	C1C2	Oscillation stabilization timeNote 2	From when VDD reaches the minimum oscillation voltage			4	ms
CrystalNote 3	Xin Xout	Oscillation frequency		1.0	4	8.0	MHz

MAIN SYSTEM CLOCK OSCILLATOR CHARACTERISTICS (TA = -20 to +75°C, VDD = 2.2 to 5.5 V)

Notes 1. The oscillation frequency is indicated only to express the oscillator characteristics.

Oscillation stabilization

2. The oscillation stabilization time is the time required for stabilizing the oscillation after VDD is applied or the STOP mode is released.

 $V_{DD} = 4.5 \text{ to } 5.5 \text{V}$

3. The recommended oscillators are shown in the table described later.

SUBSYSTEM CLOCK OSCILLATOR CHARACTERISTICS

Resonator Constants	Recommended	Item	Conditions	MIN.	TYP.	MAX.	Unit
Crystal oscillator	X _{IN} X _{OUT}	Oscillation frequency (fxт)			32.768		kHz
		Oscillation stabilization time			5	10	s

Caution When using the main system clock and the subsystem clock generators, in order to avoid wiring capacitance effects, the following notations must be read and observed for wiring the portion inside the dotted line in the table:

- · Wiring length must be minimized.
- Do not cross with other signal lines. Do not wire close to a large current line.
- Capacitors used in the oscillators must always be grounded to GND potential level. Never ground the grounding pattern having a large current flow.
- · Do not take the signal directly out of the oscillator.

In order to reduce the power consumption, the subsystem clock oscillator employs a low amplification factor circuit. Because of this, the subsystem clock oscillator is more sensitive to noise than the main system clock oscillator. Therefore, when using the subsystem clock, wiring must be carefully planned.



RECOMMENDED OSCILLATORS

Main System Clock Oscillator (made of ceramic)

		External Capacitance		Oscillation Vo	oltage Range	
Manufacturer	Part Name	(pF)		(V)		Remarks
		C1	C2	MIN.	MAX.	
	CSA3.58MG	30	30	2.0	6.0	
	CSA4.00MG	30	30	2.0	6.0	
	CSA4.19MG	30	30	2.0	6.0	
MURATA Mfg.	CST3.58MGW	Not required	Not required	2.0	6.0	
	CST4.00MGW	Not required	Not required	2.0	6.0	Built-in capacitor
	CST4.19MGW	Not required	Not required	2.0	6.0	
	KBR3.58MS	33	33	2.0	6.0	
KYOCERA	KBR4.0MS	33	33	2.0	6.0	
	KBR4.19MS	33	33	2.0	6.0	
токо	CRHF4.00	18	18	2.0	6.0	
DAISHINKU	PRS0400BCSAN	39	33	2.0	6.0	

Main System Clock Oscillator (made of crystal)

Manufacturer '			External Capacitance (pF)		Oscillation Voltage Range (V)		
		(MHz) Holder					Remarks
	(MHz)		C1	C2	MIN.	MAX.	
KINSEKI	4.0	HC-49U-S	22	22	2.0	6.0	



DC CHARACTERISTICS (TA = -20 to +75°C, VDD = VADC = 2.2 to 3.6 V)

Parameter	Symbol	Test Condition		MIN.	TYP.	MAX.	Unit
High-Level Input Voltage	V _{IH1}	RESET and INT pins		0.8V _{DD}		V _{DD}	V
	V _{IH2}	Other than RESET and INT pins		0.7V _{DD}		V _{DD}	V
Low-Level Input Voltage	VIL1	RESET and INT pins		0		0.2V _{DD}	V
	V _{IL2}	Other than RESET and INT pins		0		0.3V _{DD}	V
High-Level Input Leakage Current	ILIH1	XTIN, XTOUT, XIN, and XOUT pins				20	μΑ
	I _{LIH2}	Other than XTIN, XTOUT, XIN, and X	Коит pins			3	μΑ
Low-Level Input Leakage Current	ILIL1	XTIN, XTOUT, XIN, and XOUT pins				-20	μΑ
	ILIL2	Other than XTIN, XTOUT, XIN, and X	Коит pins			-3	μΑ
High-Level Output Current	Іон1	REM pin Voh=Vdd-1.2 V		-7	-15		mA
	Іон2	Note 1 VoH=VDD-0.3 V		-0.3	-0.7		mA
Low-Level Output Current	Ю	Note 2 Vol=0.3 V		0.5	0.9		mA
Built-In Pull-Up Resistor	R _{P0A}	P0A₀ to P0A₃ pins		100	200	350	kΩ
	RRES	RESET pins (mask option)	RESET pins (mask option)		47	94	kΩ
A/D Absolute Precision						±2	LSB
A/D Resolution					8		bits
A/D Converter Circuit Current	IADC				60	120	μΑ
Comparator Error		In comparator mode			10	20	mV
	I _{DD1}	X installed (fx=4.19 MHz)	RUN mode		0.8	2.0	mA
	I _{DD2}	XT not installed	HALT mode		0.3	1.5	mA
Supply Current	I _{DD3}	VDD=3 V	STOP mode		2.0	10	μΑ
	I _{DD4}	X not installed or STOP mode XT installed	RUN mode		7.0	25	μΑ
	IDD5 Note 3	(fxt=32.768 kHz) VDD=3 V	HALT mode		3.0	15	μΑ

Notes 1. $P0A_0$ to $P0A_3$, $P0D_0$ to $P0D_3$, and $P1A_0$ to $P1A_2$ pins

- 2. P0Ao to P0A3, P0Bo to P0B3, P0Co to P0C3, P0Do to P0D3, P1Ao to P1A2, WDOUT, and REM pins
- **3.** The specifications of the main STOP mode (sub-mounting) are the same as the sub-HALT mode (with the main clock oscillation stopped).

LCD CHARACTERISTICS (TA = -20 to +75°C, VDD = 2.2 to 3.6 V)

Parameter	Symbol	Test Condition	MIN.	TYP.	MAX.	Unit
VLCDC Output Voltage	VLCDC	$V_{DD}=3~V,~T_a=25^{\circ}C,~R1=R2=1~M\Omega$	0.5	0.6	0.7	V
LCD Reference Output Voltage	V _{LCD0}	External variable resistance (0 to 2.2 $M\Omega$)	0.8		1.8	V
Doubler Output Voltage	V _{LCD1}	C1 to C4 = 0.47 μ F	1.9	2.0		V _{LCD0}
Tripler Output Voltage	V _{LCD2}	C1 to C4 = 0.47 µF	2.85	3.0		V _{LCD0}
LCD Common Output Current	Ісом	Output voltage deviation = 0.2 V	30			μΑ
LCD Segment Output Current	ILCD	Output voltage deviation = 0.2 V	5			μΑ



DC CHARACTERISTICS (Ta = -20 to +75°C, Vdd = Vadc = 5 V ± 10 %)

Parameter	Symbol	Test Condition		MIN.	TYP.	MAX.	Unit
High-Level Input Voltage	V _{IH1}	RESET and INT pins		0.8V _{DD}		V _{DD}	V
Triigii-Level iriput voitage	V _{IH2}	Other than RESET and INT pins		0.7V _{DD}		V _{DD}	V
Low-Level Input Voltage	VIL1	RESET and INT pins		0		0.2V _{DD}	V
Low-Level Input Voltage	V _{IL2}	Other than RESET and INT pins		0		0.3V _{DD}	V
High Lovel Innut Lookage current	ILIH1	XTIN, XTOUT, XIN, and XOUT pins				20	μΑ
High-Level Input Leakage current	I _{LIH2}	Other than XTIN, XTOUT, XIN, and X	Коит pins			3	μΑ
Low-Level Input Leakage current	ILIL1	XTIN, XTOUT, XIN, and XOUT pins				-20	μΑ
Low-Level Input Leakage current	ILIL2	Other than XTIN, XTOUT, XIN, and X	Couт pins			-3	μΑ
High-Level Output Current	Іон1	REM pin Vo	он = VDD-0.6 V	-7	-15		mA
riigii-Level Output Current	10н2	Note 1	он = VDD-0.3 V	-0.8	-1.2		mA
Low-Level Output Current	Іоь	Note 2	VoL = 0.3 V	1.0	1.5		mA
Built-In Pull-Up Resistor	RPOA	P0A ₀ to P0A ₃ pins			200	350	kΩ
Built-iii i uii-op itesistoi	Rres	RESET pins (mask option)			47	94	kΩ
A/D Absolute Precision						±2	LSB
A/D Resolution					8		bits
A/D Converter Circuit Current	IADC				60	120	μΑ
Comparator Error		In comparator mode			10	20	mV
	I _{DD1}	X installed (fx=4.19 MHz)	RUN mode		1.8	5.0	mA
	I _{DD2}	XT not installed	HALT mode		0.6	2.0	mA
Supply Current	I _{DD3}	V _{DD} = 5 V	STOP mode		2.6	20	μΑ
	I _{DD4}	X not installed or STOP mode	RUN mode		10.5	40	μΑ
	I _{DD5}	XT installed $(fx = 32.768 \text{ kHz})$ VDD = 5 V	HALT mode		6.0	20	μΑ

Notes 1. $P0A_0$ to $P0A_3$, $P0D_0$ to $P0D_3$, and $P1A_0$ to $P1A_2$ pins

- 2. P0Ao to P0A3, P0Bo to P0B3, P0Co to P0C3, P0Do to P0D3, P1Ao to P1A2, REM, and WDOUT pins
- **3.** The specifications of the main STOP mode (sub-mounting) are the same as the sub-HALT mode (with the main clock oscillation stopped).

LCD CHARACTERISTICS (TA = -20 to +75°C, VDD = 5 V \pm 10%)

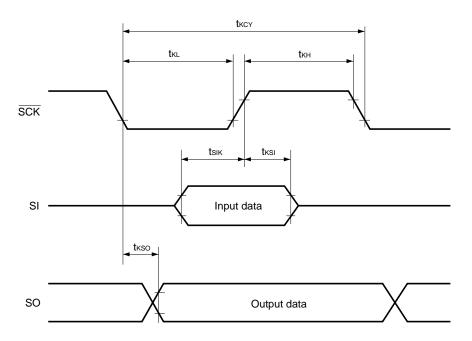
Parameter	Symbol	Test Condition	MIN.	TYP.	MAX.	Unit
LCD Reference Output Voltage	V _{LCD0}	External variable resistance (0 to 2.2 $M\Omega$)	0.8		1.8	V
Doubler Output Voltage	V _{LCD1}	C1 to C4 = 0.47 µF	1.9	2.0		V _{LCD0}
Tripler Output Voltage	V _{LCD2}	C1 to C4 = 0.47 μ F	2.85	3.0		V _{LCD0}
LCD Common Output Current	Ісом	Output voltage deviation = 0.2 V	30			μΑ
LCD Segment Output Current	ILCD	Output voltage deviation = 0.2 V	5			μΑ

AC CHARACTERISTICS (TA = -20 to +75°C, V_{DD} = 2.2 to 5.5 V)

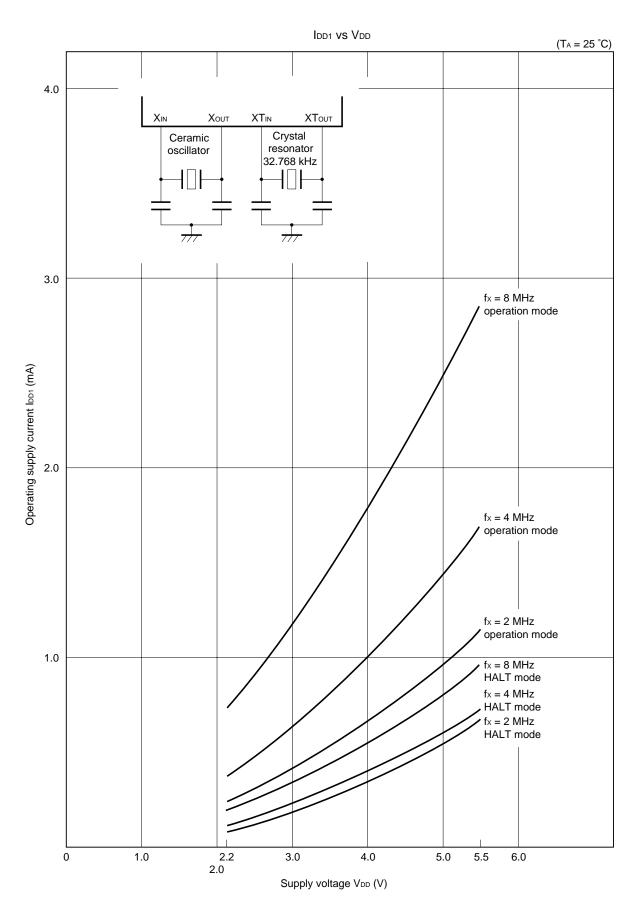
Parameter	Symbol	Test Condition		MIN.	TYP.	MAX.	Unit
SCK Input Cycle Time	tĸcy	V _{DD} =5 V±10 %	Data Input	2.0			μs
		VDD =3 V±10 /0	Data Output	10			μs
	thei		Data Input	5			μs
			Data Output	13			μs
	tĸн,	V _{DD} =5 V±10 %	Data Input	1.0			μs
SCK Input High- and Low-Level			Data Output	5.0			μs
Widths			Data Input	2.5			μs
			Data Output	6.5			μs
SI Setup Time (vs. SCK↑)	tsıĸ			100			ns
SI Hold Time (vs. SCK↑)	tĸsı			100			ns
SCK↓→to SO Output Delay Time	tĸso	C _L =100 pF				4.5	μs
INT High- and Low-Level Width	tıон, tıoL			50			μs
RESET Low-Level Width	trsl			50			μs
P0A Low-Level Width	trlsl	Standby Release		10			μs

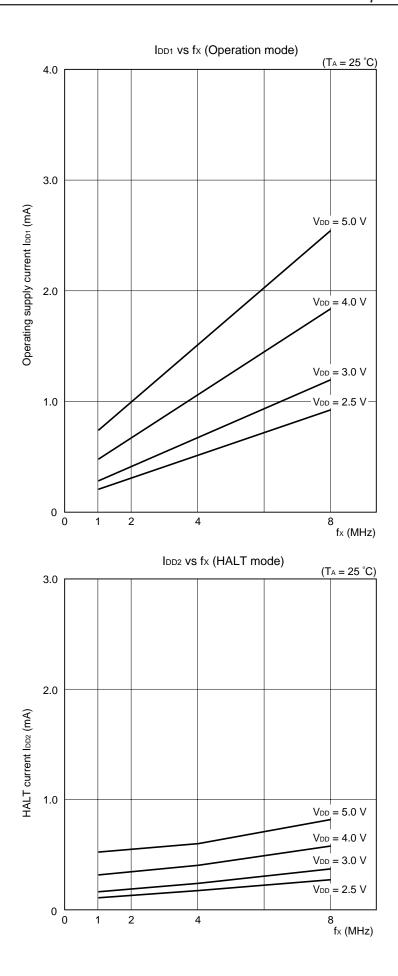
SERIAL TRANSFER TIMING

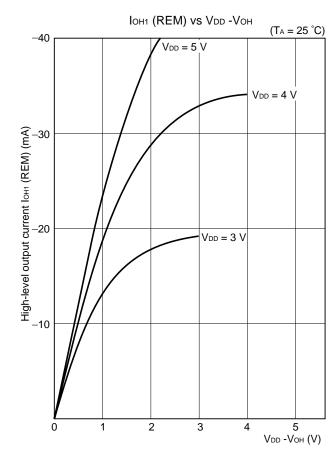
3-line Serial I/O Mode

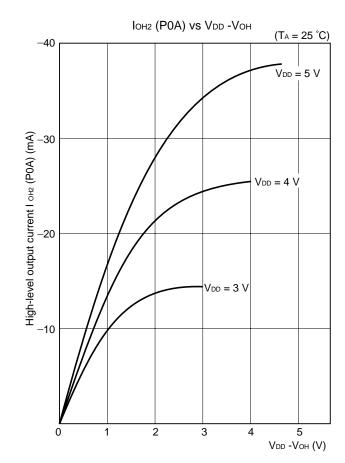


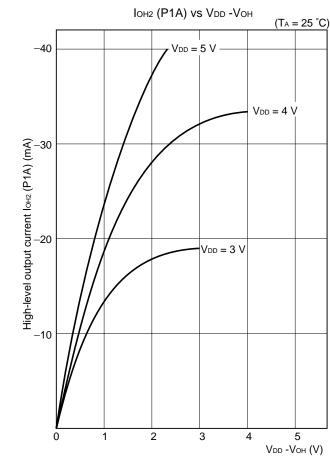
18. PERFORMANCE CURVE (REFERENCE VALUE)

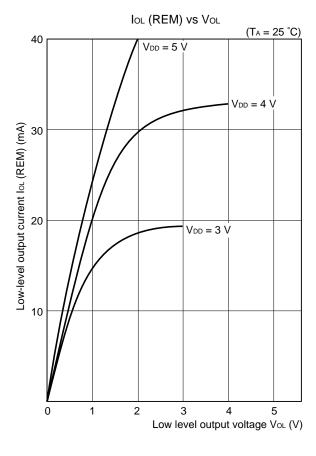


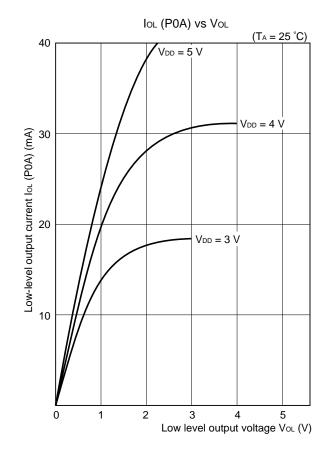


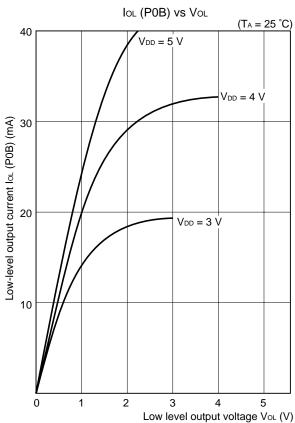


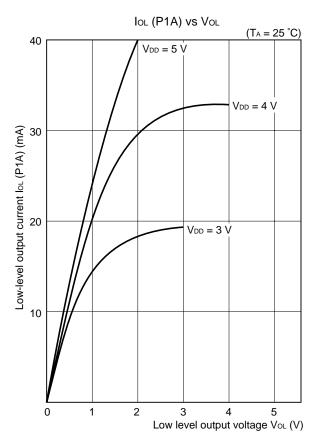






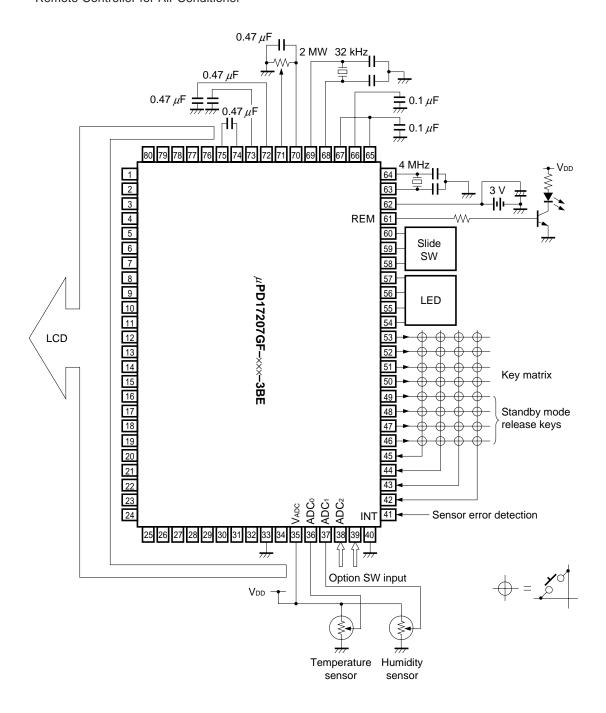






19. EXAMPLE OF APPLICATION CIRCUIT

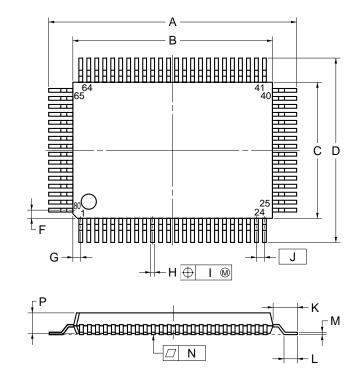
• Remote Controller for Air Conditioner



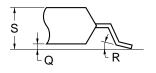
20. PACKAGE DRAWINGS

PACKAGE DRAWINGS OF MASS-PRODUCTION PRODUCT

80 PIN PLASTIC QFP (14×20)



detail of lead end



NOTE

Each lead centerline is located within 0.15 mm (0.006 inch) of its true position (T.P.) at maximum material condition.

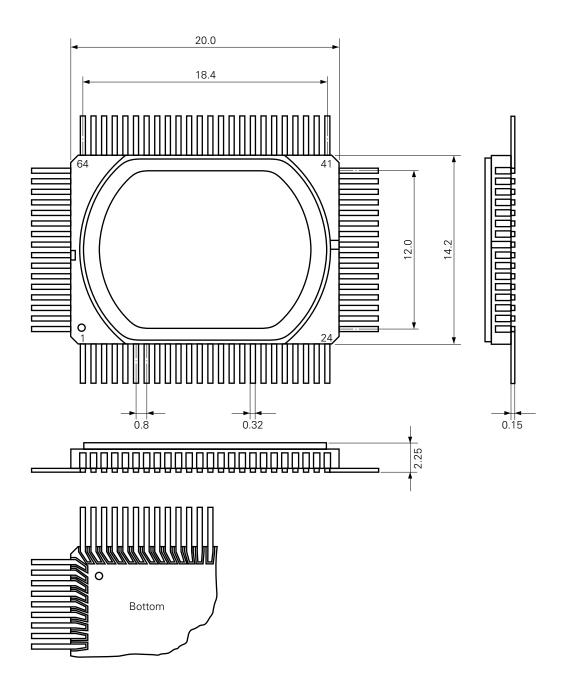
ITEM	MILLIMETERS	INCHES			
Α	23.2±0.2	$0.913^{+0.009}_{-0.008}$			
В	20.0±0.2	$0.787^{+0.009}_{-0.008}$			
С	14.0±0.2	$0.551^{+0.009}_{-0.008}$			
D	17.2±0.2	0.677±0.008			
F	1.0	0.039			
G	1.8	0.031			
Н	0.35±0.10	$0.014^{+0.004}_{-0.005}$			
I	0.15	0.006			
J	0.8 (T.P.)	0.031 (T.P.)			
K	1.6±0.2	0.063±0.008			
L	0.8±0.2	$0.031^{+0.009}_{-0.008}$			
М	$0.15^{+0.10}_{-0.05}$	$0.006^{+0.004}_{-0.003}$			
N	0.10	0.004			
Р	2.7	0.106			
Q	0.125±0.075	0.005±0.003			
R	5°±5°	5°±5°			
S	3.0 MAX.	0.119 MAX.			

S80GF-80-3B9-3

Caution The ES and mass-production products differ in external shape and materials. Please refer to the package drawing for the ES product.

ES PRODUCT PACKAGE DRAWINGS

ES 80-PIN CERAMIC QFP (For Reference) (UNIT: mm)



- Caution 1. The metal cap is connected to pin 33 and is at the GND level.
 - 2. Leads on the bottom of the package are guided slantingly.
 - 3. Package length does not include end flash burr.



21. RECOMMENDED SOLDERING CONDITIONS

For the μ PD17207, soldering must be performed under the following conditions.

For details of recommended conditions for surface mounting, refer to information document "Semiconductor Device Mounting Technology Manual" (C10535E).

For other soldering methods, please consult with NEC personnel.

Table 21-1 Soldering Conditions of Surface Mount Type

 μ PD17201AGF-xxx-3B9: 80-pin plastic QFP (14 × 20 mm) μ PD17207GF-xxx-3B9: 80-pin plastic QFP (14 × 20 mm)

Soldering Method	Soldering Conditions	Symbol
Infrared Reflow	Package peak temperature: 235°C, Time: 30 seconds max. (210°C min.), Number of times: 2 max., Days: 7 daysNote (after that, prebaking is necessary for 20 hours at 125°C) <caution> Cannot be baked while packed in anything other than a heat-resistant tray (i.e. magazine, taping or non-heat resistant tray).</caution>	IR35-207-2
VPS	Package peak temperature: 215°C, Time: 40 seconds max. (200°C min.), Number of times: 2 max., Days: 7 daysNote (after that, prebaking is necessary for 20 hours at 125°C) <caution> Cannot be baked while packed in anything other than a heat-resistant tray (i.e. magazine, taping or non-heat resistant tray).</caution>	VP15-207-2
Wave Soldering	Solder bath temperature: 260°C max., Time: 10 seconds max. Number of times: 1, Pre-heating temperature: 120°C max. (package surface temperature), Days: 7 days Note (after that, prebaking is necessary for 20 hours at 125°C)	WS60-207-1
Partial Heating	Pin temperature: 300°C max., Time: 3 seconds max. (per side of device)	

Note The number of days the device can be stored after the dry pack was opened, under storage conditions of 25°C and 65% RH max.

Caution Do not use two or more soldering methods in combination (except the partial heating method).



APPENDIX A. DIFFERENCES BETWEEN μ PD17P207 AND μ PD17201A/17207

The μ PD17P207 has a PROM to which the user can write a program in place of the internal mask ROM of the μ PD17201A and 17207. Therefore, the μ PD17P207 is identical to μ PD17201A and 17207 except for the program memory and mask option. However, **some of the electrical characteristics, such as supply current and V**LCDO **voltage of the \muPD17P207, are different from that of the \muPD17201A and 17207.**

The following table lists the differences between the μ PD17P207 and μ PD17201A/17207.

Item	μPD17P207	μPD17P207	μPD17P207	μPD17201A	μPD17207	
Product Name	-001	-002	-003			
	One-Time PROM			Mask ROM		
Program Memory		0000H-0FFFH	0000H-0BFFH	0000H-0FFFH		
	4096 × 16 bits			3072 × 16 bits	4096 × 16 bits	
Pull-Up Resistor of RESET Pin		Not provided	Not provided		·	
Main Clock Oscillator Circuit	Provided	Provided	140t provided	Any (mask option)		
Subclock Oscillator Circuit		Not provided	Provided			
V _{PP} Pin, PROM Program Pin	Provided			Not provided		
Supply Voltage (T _A = -20 to +75°C)	$V_{DD} = 2.4 \text{ to } 5.5 \text{ V}$ (at $f_X = 4 \text{ MHz}$		-60°C)	V _{DD} = 2.2 to 5.5	V (at $fx = 4 \text{ MHz}$)	
Package	80-pin plastic QFP (14 × 20			20 mm)		

Caution When using the μ PD17P207-001, be sure to connect an oscillator to both the main clock oscillation circuit and subclock oscillation circuit.



APPENDIX B. FUNCTIONAL COMPARISON OF μ PD17201A/17207 RELATED PRODUCTS

Product Name		μPD17201A	μPD17207	μPD17215	μPD17216	μPD17217	μPD17218	
Item								
ROM Capacity (bits)		3072 × 16	4096 × 16	2048 × 16	4096 × 16	6144 × 16	8192 × 16	
RAM Capacity (b	oits)	336 × 4		111 × 4 233 × 4			× 4	
LCD Controller/D	Drive	136 segments max.		Not provided				
Infrared Remote Controller Carrier Generator (REM)		LED output is high-active		Internal (no LED output)				
I/O Ports		19 li	ines		20 1	ines		
External Interrup	t (INT)	1 line (rising-edge detection)		1 line	(rising-edge, fa	alling-edge dete	ection)	
Analog Input		4 channels (8-bit A/D)		Not provided				
Timer		2 channels {	8-bit timer Watch timer	2 channels 8-bit timer Basic interval timer				
Watchdog Timer		Internal (WDOUT output)						
Low-Voltage Det	ection Circuit	Not provided Internal (WDOUT ou		OUT output)				
Serial Interface		1 cha	1 channel Not provided					
Stack		5 levels (3 levels for multiplexed interrupt)						
Instruction Execution Time Main System Clock		• •	μ s (4 MHz: with ceramic r crystal oscillator) • 2 μ s (8 MHz ceramic oscillator: in high-s • 4 μ s (4 MHz ceramic oscillator: in high-s • 16 μ s (1 MHz ceramic oscillator: in high-s			peed mode)		
Execution Time	Subsystem Clock 488 μ s (32.768 kHz: with crystal oscillator)		Not provided					
Supply Voltage	Main System Clock	2.2 to 5.5 V (at fx = 4 MHz)		2.2 to 5.5 V (at fx = 4 MHz, in high speed)			speed)	
- cappi, voltage	,		хт = 32.768 kHz)	Not provided				
Standby Function				STOP, HALT				
Pakcage		80-pin plastic QFP		28-pin plastic SOP				
				28-pin plastic shrink DIP				
One-Time PROM	One-Time PROM Product		7P207	μPD17P218				

Caution The electrical characteristics differ between the mask ROM model and one-time PROM model.



APPENDIX C. DEVELOPMENT TOOLS

The following tools are available for development of $\mu PD17207$ progams:

Hardware

Name	Outline
In-circuit Emulators (IE-17K IE-17K-ET ^{Note 1} EMU-17K ^{Note 2}	The IE-17K, IE-17K-ET, and EMU-17K are in-circuit emulators that can be commonly used with the 17K series products. The IE-17K and IE-17K-ET are connected to the host machine, which is a PC-9800 series product or IBM PC/AT TM , via RS-232-C. The EMU-17K is inserted into an expansion slot of a PC-9800 series product. When these in-circuit emulators are used in combination with a system evaluation board (SE board) dedicated to each model of the device, they operate as the emulator dedicated to that model. A more sophisticated debugging environment can be created by using the man-machine interface software, SIMPLEHOST TM . The EMU-17K has a function that allows you to check the contents of the data memory real-time.
SE Board (SE-17207)	The SE-17207 is an SE board for the μ PD17201A, 17207, and 17P207. It may be used alone to evaluate a system, or in combination with an in-circuit emulator for debugging.
Emulation Probe (EP-17201GF)	The EP-17201GF is an emulation probe for the μ PD17201A, 17207, and 17P207. It connects an SE board and the target system.
Conversion Socket (EV-9200G-80 ^{Note 3})	The EV-9200G-80 is a socket for an 80-pin QFP (14 x 20 mm) and connects the EP-17201GF and the target system.
PROM Programmer (AF-9703 ^{Note 4} , AF-9704 ^{Note 4} AF-9705 ^{Note 4} , AF-9706 ^{Note 4})	The AF9703, AF9704, AF9705, and AF9706 are PROM programmers that can program the μ PD17P207. When connected with programmer adapter AF-9808A, this PROM programmer can program the μ PD17P207.
Program Adapter (AF-9808A ^{Note 4})	The AF-9808A is an adapter for programming the μ PD17P207 and is used in combination with the AF-9703, AF-9704, AF-9705 and AF-9706.

- Notes 1. Low-cost model: external power supply type
 - 2. This is a product from I.C Corp. For details, consult I.C Corp.
 - **3.** Two EV-9200G-80s are supplied with the EP-17201GF. Five EV-9200G-80s are optionally available as a set.
 - 4. These are products from Ando Electric Co., Ltd. For details, consult Ando Electric.



Software

Name	Outline Machine	Host	OS N	/ledia	Supply	Order Code
	AS17K is an assembler in common	PC-9800 series	MS-DOS TM		5" 2HD	μS5A10AS17K
17K Series Assembler	with the 17K series products. When developing the program of the μ PD17201A and the μ PD17207, AS17K is used in combination with a device file (AS17201A, AS17207).	1 0 0000 001100			3.5" 2HD	μS5A13AS17K
(AS17K)		IBM PC/AT	PC DOS TM		5" 2HC	μS7B10AS17K
		15 1 0,711			3.5" 2HC	μS7B13AS17K
	AS17201 is a device file for	PC-9800 series M		DOS	5" 2HD	μS5A10AS17201
Device File	μ PD17201A, and it is used in combi-	1 0 0000 001100	MO DOO		3.5" 2HD	μS5A13AS17201
(AS17201)	nation with an assembler for the 17K series (AS17K)	IBM PC/AT	PC DOS		5" 2HC	μS7B10AS17201
					3.5" 2HC	μS7B13AS17201
		PC-9800 series	MS-DOS		5" 2HD	μS5A10AS17207
Device File	AS17207 is a device file for μ PD17207, and it is used in combination with an assembler for the 17K series (AS17K).	1 0 0000 001100			3.5" 2HD	μS5A13AS17207
(AS17207)		IBM PC/AT	PC DOS		5" 2HC	μS7B10AS17207
		15 1 6,711			3.5" 2HC	μS7B13AS17207
	SIMPLEHOST is a software package		MS-DOS		5" 2HD	μS5A10IE17K
Support	that enables man-machine interface on the WINDOWS TM when a program is developed by using an incircuit	. 6 6666 6666		Windows	3.5" 2HD	μS5A13IE17K
Software (SIMPLEHOST)		IBM PC/AT	PC DOS		5" 2HC	μS7B10IE17K
	emulator and a personal computer.	.2 : 6// (1	. 5 500		3.5" 2HC	μS7B13IE17K

Remark The corresponding OS versions are as follows:

os	Version
MS-DOS	Ver. 3.30 to Ver. 5.00ANote
PC DOS	Ver. 3.1 to Ver. 5.0 Note
Windows	Ver. 3.0 to Ver. 3.1

Note Ver. 5.00/5.00A of MS-DOS and Ver. 5.0 of PC DOS have a task swap function, but this function cannot be used with this software.

NOTES FOR CMOS DEVICES -

1 PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

Note: Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

(2) HANDLING OF UNUSED INPUT PINS FOR CMOS

Note: No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS device behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

③ STATUS BEFORE INITIALIZATION OF MOS DEVICES

Note: Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

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- · Device availability
- · Ordering information
- · Product release schedule
- Availability of related technical literature
- Development environment specifications (for example, specifications for third-party tools and components, host computers, power plugs, AC supply voltages, and so forth)
- · Network requirements

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